

KSZ8051MNLU/KSZ8051RNLU

10Base-T/100Base-TX Physical Layer Transceiver

Data Sheet Rev. 1.0

General Description

The KSZ8051 is an AEC-Q100 standard qualified single-supply 10Base-T/100Base-TX Ethernet physical-layer transceiver for transmission and reception of data over standard CAT-5 unshielded twisted pair (UTP) cable for automotive applications.

The KSZ8051 is a highly-integrated PHY solution. It reduces board cost and simplifies board layout by using on-chip termination resistors for the differential pairs and by integrating a low-noise regulator to supply the 1.2V core.

The KSZ8051MNLU offers the Media Independent Interface (MII) and the KSZ8051RNLU offers the Reduced Media Independent Interface (RMII) for direct connection with MII/RMII-compliant Ethernet MAC processors and switches.

A 25MHz crystal is used to generate all required clocks, including the 50MHz RMII reference clock output for the KSZ8051RNLU.

The KSZ8051 provides diagnostic features to facilitate system bring-up and debugging in production testing and in product deployment. Parametric NAND tree support enables fault detection between KSZ8051 I/Os and the board. Micrel LinkMD® TDR-based cable diagnostics identify faulty copper cabling.

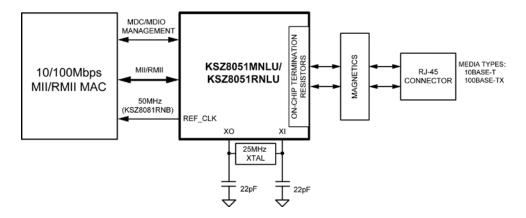
The KSZ8051MNLU and KSZ8051RNLU are available in 32-pin, lead-free QFN packages (see "Ordering Information").

Data sheets and support documentation are available on Micrel's web site at: www.micrel.com.

Features

- Single-chip 10Base-T/100Base-TX IEEE 802.3 compliant Ethernet transceiver
- AEC-Q100 qualified for automotive applications
- MII interface support (KSZ8051MNLU)
- RMII v1.2 Interface support with a 50MHz reference clock output to MAC, and an option to input a 50MHz reference clock (KSZ8051RNLU)
- Back-to-back mode support for a 100Mbps copper repeater
- MDC/MDIO management interface for PHY register configuration
- Programmable interrupt output
- LED outputs for link, activity, and speed status indication
- On-chip termination resistors for the differential pairs
- Baseline wander correction
- HP Auto MDI/MDI-X to reliably detect and correct straight-through and crossover cable connections with disable and enable option
- Auto-negotiation to automatically select the highest linkup speed (10/100Mbps) and duplex (half/full)
- · Power-down and power-saving modes
- LinkMD TDR-based cable diagnostics to identify faulty copper cabling
- Parametric NAND Tree support for fault detection between chip I/Os and the board

Functional Diagram



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Features (Continued)

- Loopback modes for diagnostics
- Single 3.3V power supply with VDD I/O options for 1.8V, 2.5V, or 3.3V
- Built-in 1.2V regulator for core
- 32-pin (5mm x 5mm) QFN package

Applications

• Automotive (throughout vehicle)

Ordering Information

Part Number	Temperature Range	Package	Lead Finish	Wire Bonding	Description
KSZ8051MNLU (1)	-40°C to 85°C 32-Pin QFN		Pb-Free		MII, Automotive Qualified Device
KSZ8051RNLU (1)	–40°C to 85°C	32-Pin QFN	Pb-Free		RMII, Automotive Qualified Device

Note:

1. Contact factory for lead time.

Revision History

Revision	Date	Summary of Changes
0.1	7/6/12	Initial Release
0.2	7/9/12	Added AEC-Q100 qualified to General Description and Features on page 1.
1.0	2/17/13	General upgrade to align to KSZ8081 DS. Loopback details added.

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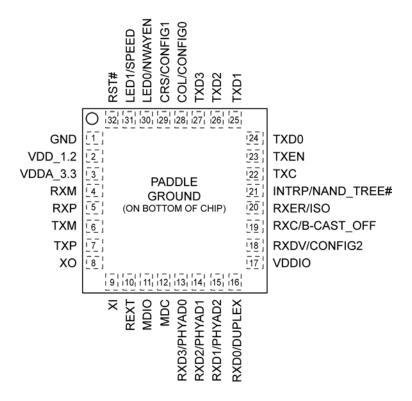
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Pin Configuration- KSZ8051MNLU



32-Pin (5mm x 5mm) QFN

Pin Description- KSZ8051MNLU

Pin Number	Pin Name	Type ⁽¹⁾	Pin Function		
1	GND	Gnd	Ground		
2	VDD_1.2	Р	1.2V core V _{DD} (p	power supplied by KSZ8051MNLU)	
			Decouple with 2.2µF and 0.1µF capacitors to ground.		
3	VDDA_3.3	Р	3.3V analog V _{DI}	D	
4	RXM	I/O	Physical receive	e or transmit signal (- differential)	
5	RXP	I/O	Physical receive	e or transmit signal (+ differential)	
6	TXM	I/O	Physical transm	nit or receive signal (- differential)	
7	TXP	I/O	Physical transm	nit or receive signal (+ differential)	
8	XO	0	Crystal feedbac	k for 25MHz crystal	
			This pin is a no	connect if an oscillator or external clock source is used.	
9	XI	1	Crystal / Oscilla	tor / External Clock input	
			25MHz ±50ppm	1	
10	REXT	1	Set PHY transm	nit output current	
			Connect a 6.49	$k\Omega$ resistor to ground on this pin.	
11	MDIO	lpu/Opu	Management In	terface (MII) Data I/O	
			This pin has a v pull-up resistor.	veak pull-up, is open-drain, and requires an external 1.0k Ω	
12	MDC	lpu	Management Interface (MII) Clock input		
			This clock pin is	s synchronous to the MDIO data pin.	
13	RXD3/	lpu/O	MII mode:	MII Receive Data Output[3] ⁽²⁾	
	PHYAD0		Config mode:	The pull-up/pull-down value is latched as PHYADDR[0] at the de-assertion of reset.	
				See the "Strapping Options" section for details.	
14	RXD2/	Ipd/O	MII mode:	MII Receive Data Output[2] ⁽²⁾	
	PHYAD1		Config mode:	The pull-up/pull-down value is latched as PHYADDR[1] at the de-assertion of reset.	
				See the "Strapping Options" section for details.	
15	RXD1/	Ipd/O	MII mode:	MII Receive Data Output[1] ⁽²⁾	
	PHYAD2		Config mode:	The pull-up/pull-down value is latched as PHYADDR[2] at the de-assertion of reset.	
				See the "Strapping Options" section for details.	
16	RXD0/	Ipu/O	MII mode:	MII Receive Data Output[0] ⁽²⁾	
	DUPLEX		Config mode:	The pull-up/pull-down value is latched as DUPLEX at the de-assertion of reset.	
				See the "Strapping Options" section for details.	
17	VDDIO	Р	3.3V, 2.5V, or 1	.8V digital V _{DD}	
18	RXDV/	lpd/O	MII mode:	MII Receive Data Valid output	
	CONFIG2		Config mode:	The pull-up/pull-down value is latched as CONFIG2 at the de-assertion of reset.	
				See the "Strapping Options" section for details.	
19	RXC/	lpd/O	MII mode:	MII Receive Clock output	
	B-CAST_OFF		Config mode:	The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.	
				See the "Strapping Options" section for details.	

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Pin Number	Pin Name	Type ⁽¹⁾	Pin Function					
20	RXER/	lpd/O	MII mode:	MII mode: MII Receive Error output				
	ISO		Config mode:	de-assertion of reset.				
			See the "Strapping Options" section for details.					
21	INTRP/	Ipu/Opu	Interrupt output:	Programmable	interrupt output			
			resistor.		en-drain, and requires an			
	NAND_Tree#		Config mode:	Config mode: The pull-up/pull-down value is latched as NAND Tree# at the de-assertion of reset.				
					ping Options" section for d	etails		
22	TXC	I/O	MII mode:		Transmit Clock output			
			MII back-to-back		Transmit Clock input			
23	TXEN	I	MII mode:	MII Transmit Er				
24	TXD0	I	MII mode:	MII Transmit Da				
25	TXD1	I	MII mode:	MII Transmit Da				
26	TXD2	I	MII mode:	MII Transmit Da	ata Input[2] ⁽³⁾			
27	TXD3	1	MII Mode:	MII Mode: MII Transmit Data Input[3] ⁽³⁾				
28	COL/	lpd/O	MII mode:	MII mode: MII Collision Detect output				
	CONFIG0		Config mode:	Config mode: The pull-up/pull-down value is latched as CONFIG0 at the de-assertion of reset.				
				See the "Strapp	oing Options" section for de	etails.		
29	CRS/	Ipd/O	MII mode:	MII mode: MII Carrier Sense output				
	CONFIG1		Config mode:	onfig mode: The pull-up/pull-down value is latched as CONFIG1 at the de-assertion of reset.				
			See the "Strapping Options" section for details.					
30	LED0/	lpu/O	LED output: Programmable LED0 output					
	NWAYEN		Config mode:	Config mode: Latched as auto-negotiation enable (register 0h, bit [12]) at the de-assertion of reset.				
				See the "Strapp	oing Options" section for de	etails.		
			The LED0 pin is follows.	programmable u	sing register 1Fh bits [5:4]	, and is defined as		
			LED mode =	[00]		7		
			Link/Activity	Pin State	LED Definition			
			No link	High	OFF	1		
			Link	Low	ON	1		
			Activity	Toggle	Blinking	1		
			LED mode = [01]					
			Link	Pin State	LED Definition	1		
			No link	High	OFF	1		
			Link	Low	ON	1		
				I	1	_		
			LED mode = [1	0], [11] Reser	ved			

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Pin Number	Pin Name	Type ⁽¹⁾	Pin Function				
31	LED1/	lpu/O	LED output:	Programmable LED1 output			
	SPEED		Config mode:	Latched as Speed (reset.	register 0h, bit [13]) at	the de-assertion of	
				See the "Strapping	Options" section for de	etails.	
			The LED1 pin is programmable using register 1Fh bits [5:4], and is defined as follows.				
			LED mode =	- i	LED Definition		
			Speed	Pin State	LED Definition		
			10Base-T	High	OFF		
			100Base-TX	Low	ON		
			LED mode =	[01]]	
			Activity	Pin State	LED Definition		
			No activity	High	OFF		
			Activity	Toggle	Blinking		
			LED mode = [10], [11] Reserved			
32	RST#	lpu	Chip reset (active low)				
PADDLE	GND	Gnd	Ground				

Notes:

1. P = Power supply.

Gnd = Ground.

I = Input.

O = Output.

I/O = Bi-directional.

Ipu = Input with internal pull-up (see "Electrical Characteristics" for value).

Ipu/O = Input with internal pull-up (see "Electrical Characteristics" for value) during power-up/reset; output pin otherwise.

Ipd/O = Input with internal pull-down (see "Electrical Characteristics" for value) during power-up/reset; output pin otherwise.

Ipu/Opu = Input with internal pull-up (see "Electrical Characteristics" for value) and output with internal pull-up (see "Electrical Characteristics" for value).

- 2. MII RX Mode: The RXD[3:0] bits are synchronous with RXC. When RXDV is asserted, RXD[3:0] presents valid data to the MAC. RXD[3:0] is invalid data from the PHY when RXDV is de-asserted.
- MII TX Mode: The TXD[3:0] bits are synchronous with TXC. When TXEN is asserted, TXD[3:0] presents valid data from the MAC. TXD[3:0] has no
 effect on the PHY when TXEN is de-asserted.

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Strapping Options – KSZ8051MNLU

Pin Number	Pin Name	Type ⁽¹⁾	Pin Function						
15	PHYAD2	lpd/O	PHYAD[2:0] is latched at de-assertion of reset and is configurable to any value from 0						
14	PHYAD1	lpd/O	to 7 with PHY Address 1 as the default value.						
13	PHYAD0	lpu/O		ed by default as the broadcast PHY ad Y address after pulling the B-CAST_O 16h, bit [9].					
			PHY Address bits [4:3] a	PHY Address bits [4:3] are set to 00 by default.					
18	CONFIG2	lpd/O	The CONFIG[2:0] strap-in	n pins are latched at the de-assertion o	of reset.				
29	CONFIG1	lpd/O	CONFIG[2:0]	Mode					
28	CONFIG0	lpd/O	000	MII (default)					
			110	MII back-to-back					
			001 – 101, 111	Reserved – not used					
20	ISO	lpd/O	Isolate mode						
			Pull-up = Enable	9					
			Pull-down (defa	ult) = Disable					
			At the de-assertion of res	et, this pin value is latched into registe	r 0h, bit [10].				
31	SPEED	lpu/O	Speed mode						
			Pull-up (default) = 100Mbps						
			Pull-down = 10Mbps						
			At the de-assertion of reset, this pin value is latched into register 0h, bit [13] as the speed select, and also is latched into register 4h (auto-negotiation advertisement) as the speed capability support.						
16	DUPLEX	lpu/O	Duplex mode						
			Pull-up (default)	= Half-duplex					
			Pull-down = Full-duplex						
			At the de-assertion of reset, this pin value is latched into register 0h, bit [8].						
30	NWAYEN	lpu/O	Nway auto-negotiation enable						
			Pull-up (default)	= Enable auto-negotiation					
			Pull-down = Disable auto-negotiation						
			At the de-assertion of reset, this pin value is latched into register 0h, bit [12].						
19	B-CAST_OFF	lpd/O	Broadcast off – for PHY Address 0						
			Pull-up = PHY Address 0 is set as an unique PHY address						
			Pull-down (default) = PHY Address 0 is set as a broadcast PHY address						
			At the de-assertion of reset, this pin value is latched by the chip.						
21	NAND_Tree#	lpu/Opu	NAND tree mode						
			Pull-up (default)	= Disable					
			Pull-down = Enable						
			At the de-assertion of res	et, this pin value is latched by the chip					

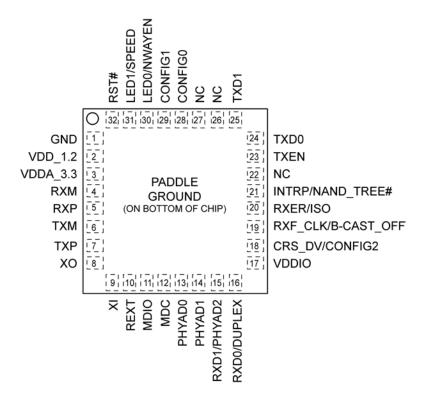
Note:

Ipu/O = Input with internal pull-up (see "Electrical Characteristics" for value) during power-up/reset; output pin otherwise.
 Ipd/O = Input with internal pull-down (see "Electrical Characteristics" for value) during power-up/reset; output pin otherwise.
 Ipu/Opu = Input with internal pull-up (see "Electrical Characteristics" for value) and output with internal pull-up (see "Electrical Characteristics" for value).

The strap-in pins are latched at the de-assertion of reset. In some systems, the MAC MII receive input pins may drive high/low during power-up or reset, and consequently cause the PHY strap-in pins on the MII signals to be latched to unintended high/low states. In this case, external pull-ups $(4.7k\Omega)$ or pull-downs $(1.0k\Omega)$ should be added on these PHY strap-in pins to ensure that the intended values are strapped-in correctly.

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Pin Configuration - KSZ8051RNLU



32-Pin (5mm x 5mm) QFN

Pin Description- KSZ8051RNLU

1	Pin Number	Pin Name	Type ⁽¹⁾	Pin Function		
Decouple with 2.2µF and 0.1µF capacitors to ground. 3	1	GND	Gnd	Ground		
3	2	VDD_1.2	Р	1.2V core V _{DD} (power supplied by KSZ8051RNLU)		
RXM				Decouple with 2	2.2μF and 0.1μF capacitors to ground.	
5	3	VDDA_3.3	Р	3.3V analog V _{DE}		
6 TXM I/O Physical transmit or receive signal (- differential) 7 TXP I/O Physical transmit or receive signal (+ differential) 8 XO O Crystal feedback for 25MHz crystal 7 TXP I/O Physical transmit or receive signal (+ differential) 8 XO O Crystal feedback for 25MHz crystal 7 This pin is a no connect if an oscillator or external clock source is used. 9 XI I 25MHz bin in it is an occillator or external clock input 10 REXT I Set PHY transmit output current 10 Connect a 6 49kΩ resistor to ground on this pin. 11 MDIO Ipu/Opu Management Interface (MII) Data I/O 11 MDC Ipu Management Interface (MII) Clock input 12 MDC Ipu Management Interface (MII) Clock input 13 PHYAD0 Ipu The pull-up/pull-down value is latched as PHYADDR[0] at the de-assertion of reset. 14 PHYAD1 Ipd/O The pull-up/pull-down value is latched as PHYADDR[1] at the de-assertion of reset. 15	4	RXM	I/O	Physical receive	e or transmit signal (- differential)	
TXP	5	RXP	I/O	Physical receive	e or transmit signal (+ differential)	
Source	6	TXM	I/O	Physical transm	it or receive signal (- differential)	
This pin is a no connect if an oscillator or external clock source is used. Soll	7	TXP	I/O	Physical transm	it or receive signal (+ differential)	
Start Sta	8	XO	0	Crystal feedbac	k for 25MHz crystal	
SOMHz Mode: 50MHz ±50ppm Oscillator / External Clock Input				This pin is a no	connect if an oscillator or external clock source is used.	
10 REXT I Set PHY transmit output current Connect a 6.49kΩ resistor to ground on this pin.	9	XI	I	25MHz Mode:	25MHz ±50ppm Crystal / Oscillator / External Clock Input	
Connect a 6.49kΩ resistor to ground on this pin.				50MHz Mode:	50MHz ±50ppm Oscillator / External Clock Input	
MDIO	10	REXT	1	Set PHY transm	nit output current	
This pin has a weak pull-up, is open-drain, and requires an external 1.0kΩ pull-up resistor. MDC				Connect a 6.49k	κΩ resistor to ground on this pin.	
Description	11	MDIO	lpu/Opu	Management In	terface (MII) Data I/O	
This clock pin is synchronous to the MDIO data pin. The pull-up/pull-down value is latched as PHYADDR[0] at the de-assertion of reset. See the "Strapping Options" section for details. PHYAD1						
PHYADO	12	MDC	lpu	Management Interface (MII) Clock input		
reset. See the "Strapping Options" section for details. 14 PHYAD1				This clock pin is synchronous to the MDIO data pin.		
reset. See the "Strapping Options" section for details. RXD1/ PHYAD2 PH	13	PHYAD0	lpu/O			
PHYAD2 Config mode: The pull-up/pull-down value is latched as PHYADDR[2] at the de-assertion of reset. See the "Strapping Options" section for details. RXD0/ DUPLEX Pull-up/Dull-down value is latched as DUPLEX at the de-assertion of reset. See the "Strapping Options" section for details. The pull-up/pull-down value is latched as DUPLEX at the de-assertion of reset. See the "Strapping Options" section for details. RMII carrier Sense/Receive Data Valid output / CONFIG2 RMII mode: RMII Carrier Sense/Receive Data Valid output / Config mode: The pull-up/pull-down value is latched as CONFIG2 at the de-assertion of reset. See the "Strapping Options" section for details. REF_CLK/ Ipd/O RMII mode: 25MHz mode: This pin provides the 50MHz RMII reference clock output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset. Config mode: The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.	14	PHYAD1	lpd/O	The pull-up/pull-down value is latched as PHYADDR[1] at the de-assertion of reset. See the "Strapping Options" section for details.		
de-assertion of reset. See the "Strapping Options" section for details. 16 RXD0/ DUPLEX Pu/O DUPLEX RMII mode: Config mode: The pull-up/pull-down value is latched as DUPLEX at the de-assertion of reset. See the "Strapping Options" section for details. 17 VDDIO P 3.3V, 2.5V, or 1.8V digital Vpd 18 CRS_DV/ CONFIG2 RMII mode: Config mode: The pull-up/pull-down value is latched as CONFIG2 at the de-assertion of reset. See the "Strapping Options" section for details. 19 REF_CLK/ Ipd/O RMII mode: 25MHz mode: This pin provides the 50MHz RMII reference clock output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). 50MHz mode: The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.	15	RXD1/	Ipd/O	RMII mode:	RMII Receive Data Output[1] ⁽²⁾	
RXDO/ DUPLEX		PHYAD2		Config mode:		
DUPLEX Config mode: The pull-up/pull-down value is latched as DUPLEX at the de-assertion of reset. See the "Strapping Options" section for details. 17 VDDIO P 3.3V, 2.5V, or 1.8V digital VDD 18 CRS_DV/ Ipd/O RMII mode: RMII Carrier Sense/Receive Data Valid output / CONFIG2 Config mode: The pull-up/pull-down value is latched as CONFIG2 at the de-assertion of reset. See the "Strapping Options" section for details. 19 REF_CLK/ Ipd/O RMII mode: 25MHz mode: This pin provides the 50MHz RMII reference clock output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). Config mode: The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.					See the "Strapping Options" section for details.	
de-assertion of reset. See the "Strapping Options" section for details. 17 VDDIO P 3.3V, 2.5V, or 1.8V digital V _{DD} 18 CRS_DV/ Ipd/O RMII mode: RMII Carrier Sense/Receive Data Valid output / CONFIG2 Config mode: The pull-up/pull-down value is latched as CONFIG2 at the de-assertion of reset. See the "Strapping Options" section for details. 19 REF_CLK/ Ipd/O RMII mode: 25MHz mode: This pin provides the 50MHz RMII reference clock output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). Config mode: The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.	16	RXD0/	lpu/O	RMII mode:	RMII Receive Data Output[0] ⁽²⁾	
17 VDDIO P 3.3V, 2.5V, or 1.8V digital VDD 18 CRS_DV/ Ipd/O RMII mode: RMII Carrier Sense/Receive Data Valid output / CONFIG2 The pull-up/pull-down value is latched as CONFIG2 at the de-assertion of reset. See the "Strapping Options" section for details. 19 REF_CLK/ Ipd/O RMII mode: 25MHz mode: This pin provides the 50MHz RMII reference clock output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). Config mode: The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.		DUPLEX		Config mode:		
18 CRS_DV/ CONFIG2 RMII mode: RMII Carrier Sense/Receive Data Valid output / Config mode: The pull-up/pull-down value is latched as CONFIG2 at the de-assertion of reset. See the "Strapping Options" section for details. 19 REF_CLK/ Ipd/O RMII mode: 25MHz mode: This pin provides the 50MHz RMII reference clock output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.					See the "Strapping Options" section for details.	
CONFIG2 Config mode: The pull-up/pull-down value is latched as CONFIG2 at the de-assertion of reset. See the "Strapping Options" section for details. REF_CLK/ Ipd/O RMII mode: 25MHz mode: This pin provides the 50MHz RMII reference clock output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.	17	VDDIO	Р	3.3V, 2.5V, or 1	.8V digital V _{DD}	
de-assertion of reset. See the "Strapping Options" section for details. 19 REF_CLK/ Ipd/O RMII mode: 25MHz mode: This pin provides the 50MHz RMII reference clock output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.	18	CRS_DV/	lpd/O	RMII mode:	RMII Carrier Sense/Receive Data Valid output /	
19 REF_CLK/ Ipd/O RMII mode: 25MHz mode: This pin provides the 50MHz RMII reference clock output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). Config mode: The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.		CONFIG2		Config mode:		
output to the MAC. See also XI (pin 9). 50MHz mode: This pin is a no connect. See also XI (pin 9). Config mode: The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.					See the "Strapping Options" section for details.	
B-CAST_OFF Config mode: The pull-up/pull-down value is latched as B-CAST_OFF at the de-assertion of reset.	19	REF_CLK/	lpd/O	RMII mode:		
de-assertion of reset.					50MHz mode: This pin is a no connect. See also XI (pin 9).	
See the "Strapping Options" section for details.		B-CAST_OFF		Config mode:		
					See the "Strapping Options" section for details.	

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RXER/ ISO	lpd/O	RMII mode:	RMII Receive Erro	or output				
				output				
		Config mode:	ISOLATE at the					
		See the "Strapping Options" section for details.						
INTRP/	lpu/Opu	Interrupt output:	Interrupt output: Programmable interrupt output					
		This pin has a w resistor.	This pin has a weak pull-up, is open-drain, and requires an external 1.0k Ω pull-up resistor.					
NAND_Tree#		Config mode:	The pull-up/pull-dede-assertion of res	own value is latched as set.	NAND Tree# at the			
			See the "Strapping	g Options" section for d	etails.			
NC	-	No connect – Th	is pin is not bonded	and can be left floating				
TXEN	I		•					
TXD0	1	RMII Transmit D	ata Input[0] ⁽³⁾					
TXD1	I	RMII Transmit D	ata Input[1] ⁽³⁾					
NC	-	No connect – Th	nis pin is not bonded	and can be left floating				
NC	-	No connect – This pin is not bonded and can be left floating.						
CONFIG0	lpd/O	The pull-up/pull-down value is latched as CONFIG0 at the de-assertion of reset. See the "Strapping Options" section for details.						
CONFIG1	lpd/O	The pull-up/pull-down value is latched as CONFIG1 at the de-assertion of reset. See the "Strapping Options" section for details.						
LED0/	lpu/O	LED output: Programmable LED0 output						
NWAYEN		Config mode:			ter 0h, bit [12]) at the			
			See the "Strapping	Options" section for de	etails.			
		The LED0 pin is follows.	programmable usin	g register 1Fh bits [5:4]	, and is defined as			
		LED mode =	[00]]			
			Pin State	LED Definition				
		No link	High	OFF				
		Link	Low	ON				
		Activity Toggle Blinking						
		LED mode = [01]						
		LED mode = [10], [11] Reserved	d				
	NC TXEN TXD0 TXD1 NC NC CONFIG0 CONFIG1 LED0/	NC - TXEN I TXD0 I TXD1 I NC - NC - CONFIG0 Ipd/O CONFIG1 Ipd/O	NAND_Tree# Config mode:	resistor. Config mode: The pull-up/pull-de-assertion of re See the "Strapping NC	resistor. Config mode: The pull-up/pull-down value is latched as de-assertion of reset. See the "Strapping Options" section for de de-assertion of reset. See the "Strapping Options" section for de de-assertion of reset. See the "Strapping Options" section for de dela de de-assertion of reset. RMII Transmit Data Input[0] (3) TXD1			

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Pin Number	Pin Name	Type ⁽¹⁾	Pin Function			
31	LED1/	lpu/O	LED output:	Programmable LED	01 output	
	SPEED		Config mode:	Latched as Speed (register 0h, bit [13]) at the de-assertion of reset.		
				See the "Strapping	Options" section for de	etails.
			The LED1 pin is programmable using register 1Fh bits [5:4], and is defined as follows. LED mode = [00]			
				- i	LED Definition	
			Speed	Pin State	LED Definition	-
			10Base-T	High	OFF	
			100Base-TX	Low	ON	
			LED mode =	[01]]
			Activity	Pin State	LED Definition	
			No activity	High	OFF	
			Activity	Toggle	Blinking	
			LED mode = [1	10], [11] Reserved		
32	RST#	lpu	Chip reset (active low)			
PADDLE	GND	Gnd	Ground			

Notes:

P = Power supply.

Gnd = Ground.

I = Input.

O = Output.

I/O = Bi-directional.

Ipu = Input with internal pull-up (see "Electrical Characteristics" for value).

Ipu/O = Input with internal pull-up (see "Electrical Characteristics" for value) during power-up/reset; output pin otherwise.

Ipd/O = Input with internal pull-down (see "Electrical Characteristics" for value) during power-up/reset; output pin otherwise.

Ipu/Opu = Input with internal pull-up (see "Electrical Characteristics" for value) and output with internal pull-up (see "Electrical Characteristics" for value).

NC = Pin is not bonded to the die.

- 2. RMII RX Mode: The RXD[1:0] bits are synchronous with the 50MHz RMII Reference Clock. For each clock period in which CRS_DV is asserted, two bits of recovered data are sent by the PHY to the MAC.
- 3. RMII TX Mode: The TXD[1:0] bits are synchronous with the 50MHz RMII Reference Clock. For each clock period in which TXEN is asserted, two bits of data are received by the PHY from the MAC.

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Strapping Options – KSZ8051RNLU

Pin Number	Pin Name	Type ⁽¹⁾	Pin Function					
15	PHYAD2	lpd/O		assertion of reset and is configurable	e to any value from 0			
14	PHYAD1	Ipd/O	to 7 with PHY Address 1 as the					
13	PHYAD0	lpu/O		y default as the broadcast PHY add ddress after pulling the B-CAST_OF , bit [9].				
			PHY Address bits [4:3] are se	et to 00 by default.				
18	CONFIG2	Ipd/O	The CONFIG[2:0] strap-in pir	s are latched at the de-assertion of	reset.			
29	CONFIG1	Ipd/O	CONFIG[2:0]	Mode				
28	CONFIG0	Ipd/O	001 RMII					
			101	RMII back-to-back				
			000, 010 – 100, 110, 111	Reserved – not used				
20	ISO	Ipd/O	Isolate mode					
			Pull-up = Enable					
			Pull-down (default) = Disable					
			At the de-assertion of reset, this pin value is latched into register 0h, bit [10].					
31	SPEED	Ipu/O	Speed mode					
			Pull-up (default) = 100Mbps					
			Pull-down = 10Mbps					
			At the de-assertion of reset, this pin value is latched into register 0h, bit [13] as the speed select, and also is latched into register 4h (auto-negotiation advertisement) as the speed capability support.					
16	DUPLEX	lpu/O	Duplex mode					
			Pull-up (default) = H	alf-duplex				
			Pull-down = Full-dup	olex				
			At the de-assertion of reset, t	his pin value is latched into register	0h, bit [8].			
30	NWAYEN	Ipu/O	Nway auto-negotiation enable	9				
			Pull-up (default) = E	nable auto-negotiation				
			Pull-down = Disable	auto-negotiation				
			At the de-assertion of reset, t	his pin value is latched into register	0h, bit [12].			
19	B-CAST_OFF	Ipd/O	Broadcast off – for PHY Addr	ess 0				
			Pull-up = PHY Address 0 is set as an unique PHY address					
			Pull-down (default) = PHY Address 0 is set as a broadcast PHY address					
			At the de-assertion of reset, this pin value is latched by the chip.					
21	NAND_Tree#	lpu/Opu	NAND tree mode					
			Pull-up (default) = D	isable				
			Pull-down = Enable					
			At the de-assertion of reset, t	his pin value is latched by the chip.	At the de-assertion of reset, this pin value is latched by the chip.			

Note:

Ipu/O = Input with internal pull-up (see "Electrical Characteristics" for value) during power-up/reset; output pin otherwise.
 Ipd/O = Input with internal pull-down (see "Electrical Characteristics" for value) during power-up/reset; output pin otherwise.
 Ipu/Opu = Input with internal pull-up (see "Electrical Characteristics" for value) and output with internal pull-up (see "Electrical Characteristics" for value).

The strap-in pins are latched at the de-assertion of reset. In some systems, the MAC MII receive input pins may drive high/low during power-up or reset, and consequently cause the PHY strap-in pins on the RMII signals to be latched to unintended high/low states. In this case, external pull-ups $(4.7k\Omega)$ or pull-downs $(1.0k\Omega)$ should be added on these PHY strap-in pins to ensure that the intended values are strapped-in correctly.

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Functional Description: 10Base-T/100Base-TX Transceiver

The KSZ8051 is an integrated single 3.3V supply Fast Ethernet transceiver. It is fully compliant with the IEEE 802.3 Specification, and reduces board cost and simplifies board layout by using on-chip termination resistors for the two differential pairs and by integrating the regulator to supply the 1.2V core.

On the copper media side, the KSZ8051 supports 10Base-T and 100Base-TX for transmission and reception of data over a standard CAT-5 unshielded twisted pair (UTP) cable, and HP Auto MDI/MDI-X for reliable detection of and correction for straight-through and crossover cables.

On the MAC processor side, the KSZ8051MNLU offers the Media Independent Interface (MII) and the KSZ8051RNLU offers the Reduced Media Independent Interface (RMII) for direct connection with MII and RMII compliant Ethernet MAC processors and switches, respectively.

The MII management bus option gives the MAC processor complete access to the KSZ8051 control and status registers. Additionally, an interrupt pin eliminates the need for the processor to poll for PHY status change.

The KSZ8051MNLU/RNLU is used to refer to both KSZ8051MNLU and KSZ8051RNLU versions in this data sheet.

100Base-TX Transmit

The 100Base-TX transmit function performs parallel-to-serial conversion, 4B/5B encoding, scrambling, NRZ-to-NRZI conversion, and MLT3 encoding and transmission.

The circuitry starts with a parallel-to-serial conversion, which converts the MII data from the MAC into a 125MHz serial bit stream. The data and control stream is then converted into 4B/5B coding and followed by a scrambler. The serialized data is further converted from NRZ-to-NRZI format, and then transmitted in MLT3 current output. The output current is set by an external $6.49k\Omega$ 1% resistor for the 1:1 transformer ratio.

The output signal has a typical rise/fall time of 4ns and complies with the ANSI TP-PMD standard regarding amplitude balance, overshoot, and timing jitter. The wave-shaped 10Base-T output is also incorporated into the 100Base-TX transmitter.

100Base-TX Receive

The 100Base-TX receiver function performs adaptive equalization, DC restoration, MLT3-to-NRZI conversion, data and clock recovery, NRZI-to-NRZ conversion, de-scrambling, 4B/5B decoding, and serial-to-parallel conversion.

The receiving side starts with the equalization filter to compensate for inter-symbol interference (ISI) over the twisted pair cable. Because the amplitude loss and phase distortion is a function of the cable length, the equalizer must adjust its characteristics to optimize performance. In this design, the variable equalizer makes an initial estimation based on comparisons of incoming signal strength against some known cable characteristics, then tunes itself for optimization. This is an ongoing process and self-adjusts against environmental changes such as temperature variations.

Next, the equalized signal goes through a DC-restoration and data-conversion block. The DC-restoration circuit compensates for the effect of baseline wander and improves the dynamic range. The differential data-conversion circuit converts MLT3 format back to NRZI. The slicing threshold is also adaptive.

The clock-recovery circuit extracts the 125MHz clock from the edges of the NRZI signal. This recovered clock is then used to convert the NRZI signal to NRZ format. This signal is sent through the de-scrambler, then the 4B/5B decoder. Finally, the NRZ serial data is converted to MII format and provided as the input data to the MAC.

Scrambler/De-Scrambler (100Base-TX Only)

The scrambler spreads the power spectrum of the transmitted signal to reduce electromagnetic interference (EMI) and baseline wander. The de-scrambler recovers the scrambled signal.

10Base-T Transmit

The 10Base-T drivers are incorporated with the 100Base-TX drivers to allow for transmission using the same magnetic. The drivers perform internal wave-shaping and pre-emphasis, and output 10Base-T signals with a typical amplitude of 2.5V peak. The 10Base-T signals have harmonic contents that are at least 27dB below the fundamental frequency when driven by an all-ones Manchester-encoded signal.

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10Base-T Receive

On the receive side, input buffer and level detecting squelch circuits are used. A differential input receiver circuit and a phase-locked loop (PLL) performs the decoding function. The Manchester-encoded data stream is separated into clock signal and NRZ data. A squelch circuit rejects signals with levels less than 400mV, or with short pulse widths, to prevent noise at the RXP and RXM inputs from falsely triggering the decoder. When the input exceeds the squelch limit, the PLL locks onto the incoming signal and the KSZ8051MNLU/RNLU decodes a data frame. The receive clock is kept active during idle periods between data receptions.

SQE and Jabber Function (10Base-T Only)

In 10Base-T operation, a short pulse is put out on the COL pin after each frame is transmitted. This SQE test is needed to test the 10Base-T transmit/receive path. If transmit enable (TXEN) is high for more than 20ms (jabbering), the 10Base-T transmitter is disabled and COL is asserted high. If TXEN is then driven low for more than 250ms, the 10Base-T transmitter is re-enabled and COL is de-asserted (returns to low).

PLL Clock Synthesizer

The KSZ8051MNLU/RNLU generates all internal clocks and all external clocks for system timing from an external 25MHz crystal, oscillator, or reference clock. For the KSZ8051RNLU in RMII 50MHz clock mode, these clocks are generated from an external 50MHz oscillator or system clock.

Auto-Negotiation

The KSZ8051MNLU/RNLU conforms to the auto-negotiation protocol, defined in Clause 28 of the IEEE 802.3 Specification.

Auto-negotiation allows unshielded twisted pair (UTP) link partners to select the highest common mode of operation.

During auto-negotiation, link partners advertise capabilities across the UTP link to each other and then compare their own capabilities with those they received from their link partners. The highest speed and duplex setting that is common to the two link partners is selected as the mode of operation.

The following list shows the speed and duplex operation mode from highest to lowest priority.

Priority 1: 100Base-TX, full-duplex
 Priority 2: 100Base-TX, half-duplex
 Priority 3: 10Base-T, full-duplex
 Priority 4: 10Base-T, half-duplex

If auto-negotiation is not supported or the KSZ8051MNLU/RNLU link partner is forced to bypass auto-negotiation, then the KSZ8051MNLU/RNLU sets its operating mode by observing the signal at its receiver. This is known as parallel detection, which allows the KSZ8051MNLU/RNLU to establish a link by listening for a fixed signal protocol in the absence of the auto-negotiation advertisement protocol.

Auto-negotiation is enabled by either hardware pin strapping (NWAYEN, pin 30) or software (register 0h, bit [12]).

By default, auto-negotiation is enabled after power-up or hardware reset. After that, auto-negotiation can be enabled or disabled by register 0h, bit [12]. If auto-negotiation is disabled, the speed is set by register 0h, bit [13], and the duplex is set by register 0h, bit [8].

The auto-negotiation link-up process is shown in Figure 1.

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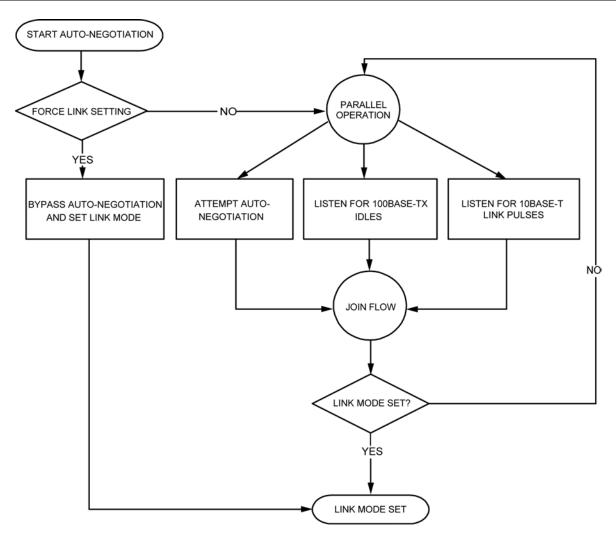


Figure 1. Auto-Negotiation Flow Chart

MII Interface (KSZ8051MNLU only)

The Media Independent Interface (MII) is compliant with the IEEE 802.3 Specification. It provides a common interface between MII PHYs and MACs, and has the following key characteristics:

- Pin count is 15 pins (6 pins for data transmission, 7 pins for data reception, and 2 pins for carrier and collision indication).
- 10Mbps and 100Mbps data rates are supported at both half- and full-duplex.
- Data transmission and reception are independent and belong to separate signal groups.
- Transmit data and receive data are each 4 bits wide, a nibble.

By default, the KSZ8051MNLU is configured to MII mode after it is powered up or hardware reset with the following:

- A 25MHz crystal connected to XI, XO (pins 9, 8), or an external 25MHz clock source (oscillator) connected to XI.
- The CONFIG[2:0] strapping pins (pins 18, 29, 28) set to 000 (default setting).

MII Signal Definition

Table 1 describes the MII signals. Refer to Clause 22 of the IEEE 802.3 Specification for detailed information.

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MII Signal Name	Direction (with respect to PHY, KSZ8051MNLU signal)	Direction (with respect to MAC)	Description
TXC	Output	Input	Transmit Clock (2.5MHz for 10Mbps; 25MHz for 100Mbps)
TXEN	Input	Output	Transmit Enable
TXD[3:0]	Input	Output	Transmit Data[3:0]
RXC	Output	Input	Receive Clock (2.5MHz for 10Mbps; 25MHz for 100Mbps)
RXDV	Output	Input	Receive Data Valid
RXD[3:0]	Output	Input	Receive Data[3:0]
RXER	Output	Input, or (not required)	Receive Error
CRS	Output	Input	Carrier Sense
COL	Output	Input	Collision Detection

Table 1. MII Signal Definition

Transmit Clock (TXC)

TXC is sourced by the PHY. It is a continuous clock that provides the timing reference for TXEN and TXD[3:0].

TXC is 2.5MHz for 10Mbps operation and 25MHz for 100Mbps operation.

Transmit Enable (TXEN)

TXEN indicates that the MAC is presenting nibbles on TXD[3:0] for transmission. It is asserted synchronously with the first nibble of the preamble and remains asserted while all nibbles to be transmitted are presented on the MII. It is negated before the first TXC following the final nibble of a frame.

TXEN transitions synchronously with respect to TXC.

Transmit Data[3:0] (TXD[3:0])

TXD[3:0] transitions synchronously with respect to TXC. When TXEN is asserted, TXD[3:0] are accepted by the PHY for transmission. TXD[3:0] is 00 to indicate idle when TXEN is de-asserted. Values other than 00 on TXD[3:0] while TXEN is de-asserted are ignored by the PHY.

Receive Clock (RXC)

RXC provides the timing reference for RXDV, RXD[3:0], and RXER.

- In 10Mbps mode, RXC is recovered from the line while the carrier is active. RXC is derived from the PHY's
 reference clock when the line is idle or the link is down.
- In 100Mbps mode, RXC is continuously recovered from the line. If the link is down, RXC is derived from the PHY's reference clock.

RXC is 2.5MHz for 10Mbps operation and 25MHz for 100Mbps operation.

Receive Data Valid (RXDV)

RXDV is driven by the PHY to indicate that the PHY is presenting recovered and decoded nibbles on RXD[3:0].

- In 10Mbps mode, RXDV is asserted with the first nibble of the start-of-frame delimiter (SFD), 5D, and remains asserted until the end of the frame.
- In 100Mbps mode, RXDV is asserted from the first nibble of the preamble to the last nibble of the frame.

RXDV transitions synchronously with respect to RXC.

Receive Data[3:0] (RXD[3:0])

RXD[3:0] transitions synchronously with respect to RXC. For each clock period in which RXDV is asserted, RXD[3:0] transfers a nibble of recovered data from the PHY.

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Receive Error (RXER)

RXER is asserted for one or more RXC periods to indicate that a symbol error (for example, a coding error that a PHY can detect that may otherwise be undetectable by the MAC sub-layer) was detected somewhere in the frame being transferred from the PHY.

RXER transitions synchronously with respect to RXC. While RXDV is de-asserted, RXER has no effect on the MAC.

Carrier Sense (CRS)

CRS is asserted and de-asserted as follows:

- In 10Mbps mode, CRS assertion is based on the reception of valid preambles. CRS de-assertion is based on the reception of an end-of-frame (EOF) marker.
- In 100Mbps mode, CRS is asserted when a start-of-stream delimiter or /J/K symbol pair is detected. CRS is deasserted when an end-of-stream delimiter or /T/R symbol pair is detected. Additionally, the PMA layer deasserts CRS if IDLE symbols are received without /T/R.

Collision (COL)

COL is asserted in half-duplex mode whenever the transmitter and receiver are simultaneously active on the line. This informs the MAC that a collision has occurred during its transmission to the PHY.

COL transitions asynchronously with respect to TXC and RXC.

MII Signal Diagram

The KSZ8051MNLU MII pin connections to the MAC are shown in Figure 2.

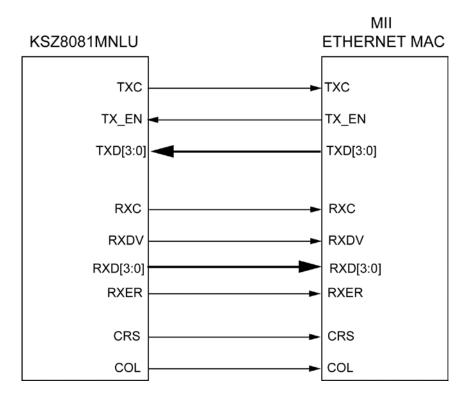


Figure 2. KSZ8051MNLU MII Interface

RMII Data Interface (KSZ8051RNLU only)

The Reduced Media Independent Interface (RMII) specifies a low pin count Media Independent Interface (MII). It provides a common interface between physical layer and MAC layer devices, and has the following key characteristics:

- Pin count is 8 pins (3 pins for data transmission, 4 pins for data reception, and 1 pin for the 50MHz reference clock).
- 10Mbps and 100Mbps data rates are supported at both half- and full-duplex.
- Data transmission and reception are independent and belong to separate signal groups.
- Transmit data and receive data are each 2 bits wide, a dibit.

RMII - 25MHz Clock Mode

The KSZ8051RNLU is configured to RMII – 25MHz clock mode after it is powered up or hardware reset with the following:

- A 25MHz crystal connected to XI, XO (pins 9, 8), or an external 25MHz clock source (oscillator) connected to XI.
- The CONFIG[2:0] strapping pins (pins 18, 29, 28) set to 001.
- Register 1Fh, bit [7] is set to 0 (default value) to select 25MHz clock mode.

RMII - 50MHz Clock Mode

The KSZ8051RNLU is configured to RMII – 50MHz clock mode after it is powered up or hardware reset with the following:

- An external 50MHz clock source (oscillator) connected to XI (pin 9).
- The CONFIG[2:0] strapping pins (pins 18, 29, 28) set to 001.
- Register 1Fh, bit [7] is set to 1 to select 50MHz clock mode.

RMII Signal Definition

Table 2 describes the RMII signals. Refer to RMII Specification v1.2 for detailed information.

RMII Signal Name	Direction (with respect to PHY, KSZ8051RNLU signal)	Direction (with respect to MAC)	Description
REF_CLK	Output (25MHz clock mode) /	Input/	Synchronous 50MHz reference clock for
	<no connect=""> (50MHz clock mode)</no>	Input or <no connect=""></no>	receive, transmit, and control interface
TXEN	Input	Output	Transmit Enable
TXD[1:0]	Input	Output	Transmit Data[1:0]
CRS_DV	Output	Input	Carrier Sense/Receive Data Valid
RXD[1:0]	Output	Input	Receive Data[1:0]
RXER	Output	Input, or (not required)	Receive Error

Table 2. RMII Signal Definition

Reference Clock (REF CLK)

REF_CLK is a continuous 50MHz clock that provides the timing reference for TXEN, TXD[1:0], CRS_DV, RXD[1:0], and RX_ER.

For 25MHz clock mode, the KSZ8051RNLU generates and outputs the 50MHz RMII REF_CLK to the MAC at REF_CLK (pin 19).

For 50MHz clock mode, the KSZ8051RNLU takes in the 50MHz RMII REF_CLK from the MAC or system board at XI (pin 9) and leaves the REF_CLK (pin 19) as a no connect.

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Transmit Enable (TXEN)

TXEN indicates that the MAC is presenting dibits on TXD[1:0] for transmission. It is asserted synchronously with the first dibit of the preamble and remains asserted while all dibits to be transmitted are presented on the RMII. It is negated before the first REF_CLK following the final dibit of a frame.

TXEN transitions synchronously with respect to REF_CLK.

Transmit Data[1:0] (TXD[1:0])

TXD[1:0] transitions synchronously with respect to REF_CLK. When TXEN is asserted, the PHY accepts TXD[1:0] for transmission.

TXD[1:0] is 00 to indicate idle when TXEN is de-asserted. The PHY ignores values other than 00 on TXD[1:0] while TXEN is de-asserted.

Carrier Sense / Receive Data Valid (CRS_DV)

The PHY asserts CRS_DV when the receive medium is non-idle. It is asserted asynchronously when a carrier is detected. This happens when squelch is passed in 10Mbps mode, and when two non-contiguous 0s in 10 bits are detected in 100Mbps mode. Loss of carrier results in the de-assertion of CRS_DV.

While carrier detection criteria are met, CRS_DV remains asserted continuously from the first recovered dibit of the frame through the final recovered dibit. It is negated before the first REF_CLK that follows the final dibit. The data on RXD[1:0] is considered valid after CRS_DV is asserted. However, because the assertion of CRS_DV is asynchronous relative to REF_CLK, the data on RXD[1:0] is 00 until receive signals are properly decoded.

Receive Data[1:0] (RXD[1:0])

RXD[1:0] transitions synchronously with respect to REF_CLK. For each clock period in which CRS_DV is asserted, RXD[1:0] transfers two bits of recovered data from the PHY.

RXD[1:0] is 00 to indicate idle when CRS_DV is de-asserted. The MAC ignores values other than 00 on RXD[1:0] while CRS_DV is de-asserted.

Receive Error (RXER)

RXER is asserted for one or more REF_CLK periods to indicate that a symbol error (for example, a coding error that a PHY can detect that may otherwise be undetectable by the MAC sub-layer) was detected somewhere in the frame being transferred from the PHY.

RXER transitions synchronously with respect to REF_CLK. . While CRS_DV is de-asserted, RXER has no effect on the MAC.

Collision Detection (COL)

The MAC regenerates the COL signal of the MII from TXEN and CRS_DV.

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RMII Signal Diagram

The KSZ8051RNLU RMII pin connections to the MAC for 25MHz clock mode are shown in Figure 3. The connections for 50MHz clock mode are shown in Figure 4.

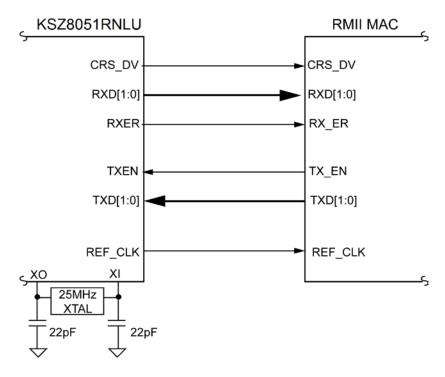


Figure 3. KSZ8051RNLU RMII Interface (25MHz Clock Mode)

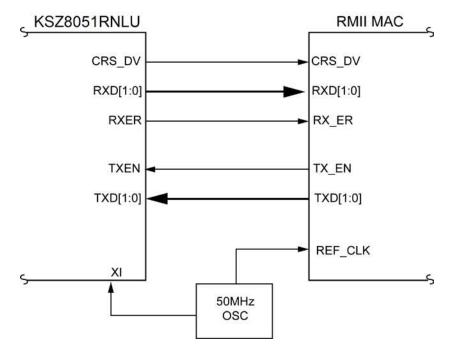


Figure 4. KSZ8051RNLU RMII Interface (50MHz Clock Mode)

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Back-to-Back Mode - 100Mbps Copper Repeater

Two KSZ8051MNLU/RNLU devices can be connected back-to-back to form a 100Base-TX copper repeater.

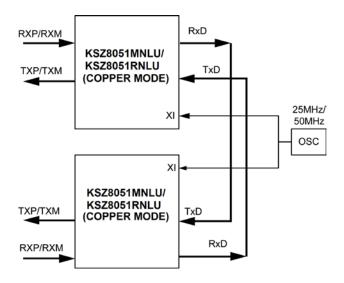


Figure 5. KSZ8051MNLU/RNLU to KSZ8051MNLU/RNLU Back-to-Back Copper Repeater

MII Back-to-Back Mode (KSZ8051MNLU only)

In MII back-to-back mode, a KSZ8051MNLU interfaces with another KSZ8051MNLU to provide a complete 100Mbps copper repeater solution.

The KSZ8051MNLU devices are configured to MII back-to-back mode after power-up or reset with the following:

- Strapping pin CONFIG[2:0] (pins 18, 29, 28) set to 110
- A common 25MHz reference clock connected to XI (pin 9) of both KSZ8051MNLU devices
- MII signals connected as shown in Table 3

KSZ805 ²	KSZ8051MNLU (100Base-TX copper) [Device 1]			IMNLU (100Base- [Device 2]	TX copper)
Pin Name	Pin Number	Pin Type	Pin Name	Pin Number	Pin Type
RXC	19	Output	TXC	22	Input
RXDV	18	Output	TXEN	23	Input
RXD3	13	Output	TXD3	27	Input
RXD2	14	Output	TXD2	26	Input
RXD1	15	Output	TXD1	25	Input
RXD0	16	Output	TXD0	24	Input
TXC	22	Input	RXC	19	Output
TXEN	23	Input	RXDV	18	Output
TXD3	27	Input	RXD3	13	Output
TXD2	26	Input	RXD2	14	Output
TXD1	25	Input	RXD1	15	Output
TXD0	24	Input	RXD0	16	Output

Table 3. MII Signal Connection for MII Back-to-Back Mode (100Base-TX Copper Repeater)

RMII Back-to-Back Mode (KSZ8051RNLU only)

In RMII back-to-back mode, a KSZ8051RNLU interfaces with another KSZ8051RNLU to provide a complete 100Mbps copper repeater solution.

The KSZ8051RNLU devices are configured to RMII back-to-back mode after power-up or reset with the following:

- Strapping pin CONFIG[2:0] (pins 18, 29, 28) set to 101
- A common 50MHz reference clock connected to XI (pin 9) of both KSZ8051RNLU devices
- RMII signals connected as shown in Table 4

KSZ8051RNLU (100Base-TX copper) [Device 1]			KSZ8051	RNLU (100Base- [Device 2]	TX copper)
Pin Name	Pin Number	Pin Type	Pin Name	Pin Number	Pin Type
CRSDV	18	Output	TXEN	23	Input
RXD1	15	Output	TXD1	25	Input
RXD0	16	Output	TXD0	24	Input
TXEN	23	Input	CRSDV	18	Output
TXD1	25	Input	RXD1	15	Output
TXD0	24	Input	RXD0	16	Output

Table 4. RMII Signal Connection for RMII Back-to-Back Mode (100Base-TX Copper Repeater)

MII Management (MIIM) Interface

The KSZ8051MNLU/RNLU supports the IEEE 802.3 MII management interface, also known as the Management Data Input/Output (MDIO) interface. This interface allows an upper-layer device, such as a MAC processor, to monitor and control the state of the KSZ8051MNLU/RNLU. An external device with MIIM capability is used to read the PHY status and/or configure the PHY settings. More details about the MIIM interface can be found in Clause 22.2.4 of the IEEE 802.3 Specification.

The MIIM interface consists of the following:

- A physical connection that incorporates the clock line (MDC) and the data line (MDIO).
- A specific protocol that operates across the physical connection mentioned earlier, which allows the external controller to communicate with one or more PHY devices.
- A set of 16-bit MDIO registers. Registers [0:8] are standard registers, and their functions are defined in the IEEE 802.3 Specification. The additional registers are provided for expanded functionality. See the "Register Map" section for details.

As the default, the KSZ8051MNLU/RNLU supports unique PHY addresses 1 to 7, and broadcast PHY address 0. The latter is defined in the IEEE 802.3 Specification, and can be used to read/write to a single KSZ8051MNLU/RNLU device, or write to multiple KSZ8051MNLU/RNLU devices simultaneously.

PHY address 0 can optionally be disabled as the broadcast address by either hardware pin strapping (B-CAST_OFF, pin 19) or software (register 16h, bit [9]), and assigned as a unique PHY address.

The PHYAD[2:0] strapping pins are used to assign a unique PHY address between 0 and 7 to each KSZ8051MNLU/RNLU device.

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Table 5 shows the MII management frame format for the KSZ8051MNLU/RNLU.

	Preamble	Start of Frame	Read/Write OP Code	PHY Address Bits [4:0]	REG Address Bits [4:0]	TA	Data Bits [15:0]	Idle
Read	32 1's	01	10	00AAA	RRRRR	Z0	DDDDDDDD_DDDDDDD	Z
Write	32 1's	01	01	00AAA	RRRRR	10	DDDDDDDD_DDDDDDD	Z

Table 5. MII Management Frame Format for the KSZ8051MNLU/RNLU

Interrupt (INTRP)

INTRP (pin 21) is an optional interrupt signal that is used to inform the external controller that there has been a status update to the KSZ8051MNLU/RNLU PHY register. Bits [15:8] of register 1Bh are the interrupt control bits to enable and disable the conditions for asserting the INTRP signal. Bits [7:0] of register 1Bh are the interrupt status bits to indicate which interrupt conditions have occurred. The interrupt status bits are cleared after reading register 1Bh.

Bit [9] of register 1Fh sets the interrupt level to active high or active low. The default is active low.

The MII management bus option gives the MAC processor complete access to the KSZ8051MNLU/RNLU control and status registers. Additionally, an interrupt pin eliminates the need for the processor to poll the PHY for status change.

HP Auto MDI/MDI-X

HP Auto MDI/MDI-X configuration eliminates the need to decide whether to use a straight cable or a crossover cable between the KSZ8051MNLU/RNLU and its link partner. This feature allows the KSZ8051MNLU/RNLU to use either type of cable to connect with a link partner that is in either MDI or MDI-X mode. The auto-sense function detects transmit and receive pairs from the link partner and assigns transmit and receive pairs to the KSZ8051MNLU/RNLU accordingly.

HP Auto MDI/MDI-X is enabled by default. It is disabled by writing a '1' to register 1Fh, bit [13]. MDI and MDI-X mode is selected by register 1Fh, bit [14] if HP Auto MDI/MDI-X is disabled.

An isolation transformer with symmetrical transmit and receive data paths is recommended to support Auto MDI/MDI-X.

Table 6 shows how the IEEE 802.3 Standard defines MDI and MDI-X.

M	DI	MDI-X		
RJ-45 Pin	RJ-45 Pin Signal		Signal	
1	TX+	1	RX+	
2	TX-	2	RX-	
3	RX+	3	TX+	
6	RX-	6	TX-	

Table 6. MDI/MDI-X Pin Definition

Straight Cable

A straight cable connects an MDI device to an MDI-X device, or an MDI-X device to an MDI device. Figure 6 shows a typical straight cable connection between a NIC card (MDI device) and a switch or hub (MDI-X device).

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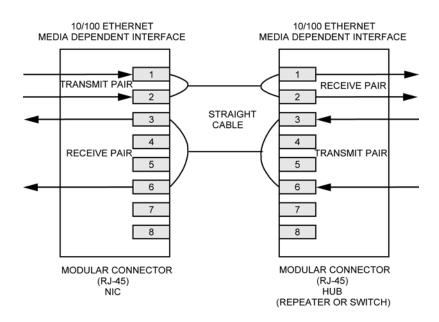


Figure 6. Typical Straight Cable Connection

Crossover Cable

A crossover cable connects an MDI device to another MDI device, or an MDI-X device to another MDI-X device. Figure 7 shows a typical crossover cable connection between two switches or hubs (two MDI-X devices).

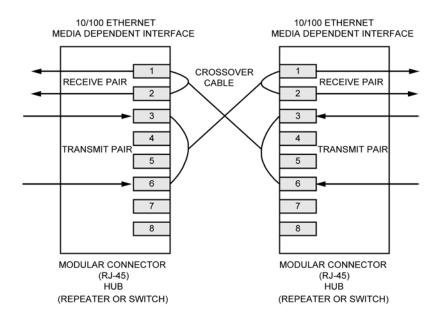


Figure 7. Typical Crossover Cable Connection

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Loopback Mode

The KSZ8051MNLU/RNLU supports the following loopback operations to verify analog and/or digital data paths.

- Local (digital) loopback
- Remote (analog) loopback

Local (Digital) Loopback

This loopback mode checks the MII/RMII transmit and receive data paths between the KSZ8051MNLU/RNLU and the external MAC, and is supported for both speeds (10/100Mbps) at full-duplex.

The loopback data path is shown in Figure 8.

- 1. The MII/RMII MAC transmits frames to the KSZ8051MNLU/RNLU.
- 2. Frames are wrapped around inside the KSZ8051MNLU/RNLU.
- 3. The KSZ8051MNLU/RNLU transmits frames back to the MII/RMII MAC.

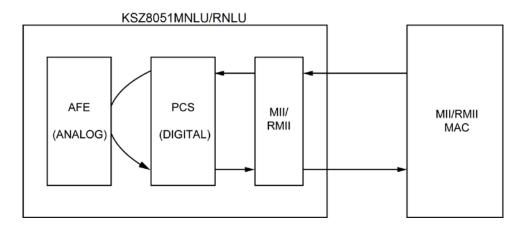


Figure 8. Local (Digital) Loopback

The following programming action and register settings are used for local loopback mode.

For 10/100Mbps loopback,

Set register 0h,

Bit [14] = 1 // Enable local loopback mode
Bit [13] = 0/1 // Select 10Mbps/100Mbps speed
Bit [12] = 0 // Disable auto-negotiation
Bit [8] = 1 // Select full-duplex mode

Remote (Analog) Loopback

This loopback mode checks the line (differential pairs, transformer, RJ-45 connector, Ethernet cable) transmit and receive data paths between the KSZ8051MNLU/RNLU and its link partner, and is supported for 100Base-TX full-duplex mode only.

The loopback data path is shown in Figure 9.

- 1. The Fast Ethernet (100Base-TX) PHY link partner transmits frames to the KSZ8051MNLU/RNLU.
- 2. Frames are wrapped around inside the KSZ8051MNLU/RNLU.
- 3. The KSZ8051MNLU/RNLU transmits frames back to the Fast Ethernet (100Base-TX) PHY link partner.

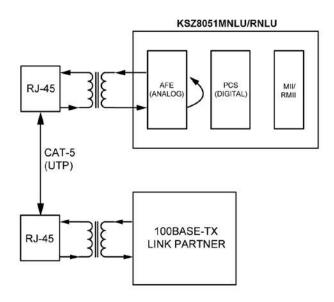


Figure 9. Remote (Analog) Loopback

The following programming steps and register settings are used for remote loopback mode.

- 1. Set Register 0h,
 - Bits [13] = 1 // Select 100Mbps speed
 - Bit [12] = 0 // Disable auto-negotiation
 - Bit [8] = 1 // Select full-duplex mode

Or just auto-negotiate and link up at 100Base-TX full-duplex mode with the link partner.

- 2. Set Register 1Fh,
 - Bit [2] = 1 // Enable remote loopback mode

LinkMD® Cable Diagnostic

The LinkMD function uses time-domain reflectometry (TDR) to analyze the cabling plant for common cabling problems. These include open circuits, short circuits, and impedance mismatches.

LinkMD works by sending a pulse of known amplitude and duration down the MDI or MDI-X pair, then analyzing the shape of the reflected signal to determine the type of fault. The time duration for the reflected signal to return provides the approximate distance to the cabling fault. The LinkMD function processes this TDR information and presents it as a numerical value that can be translated to a cable distance.

LinkMD is initiated by accessing register 1Dh, the LinkMD Control/Status register, in conjunction with register 1Fh, the PHY Control 2 register. The latter register is used to disable Auto MDI/MDI-X and to select either MDI or MDI-X as the cable differential pair for testing.

NAND Tree Support

The KSZ8051MNLU/RNLU provides parametric NAND tree support for fault detection between chip I/Os and board. The NAND tree is a chain of nested NAND gates in which each KSZ8051MNLU/RNLU digital I/O (NAND tree input) pin is an input to one NAND gate along the chain. At the end of the chain, the CRS/CONFIG1 pin provides the output for the nested NAND gates.

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The NAND tree test process includes:

- Enabling NAND tree mode
- Pulling all NAND tree input pins high
- Driving each NAND tree input pin low, sequentially, according to the NAND tree pin order
- Checking the NAND tree output to make sure there is a toggle high-to-low or low-to-high for each NAND tree input driven low

Table 7 and Table 8 list the NAND tree pin orders for KSZ8051MNLU and KSZ8051RNLU, respectively.

Pin Number	Pin Name	NAND Tree Description
11	MDIO	Input
12	MDC	Input
13	RXD3	Input
14	RXD2	Input
15	RXD1	Input
16	RXD0	Input
18	RXDV	Input
19	RXC	Input
20	RXER	Input
21	INTRP	Input
22	TXC	Input
23	TXEN	Input
24	TXD0	Input
25	TXD1	Input
26	TXD2	Input
27	TXD3	Input
30	LED0	Input
31	LED1	Input
28	COL	Input
29	CRS	Output

Table 7. NAND Tree Test Pin Order for KSZ8051MNLU

Pin Number	Pin Name	NAND Tree Description
11	MDIO	Input
12	MDC	Input
13	PHYAD0	Input
14	PHYAD1	Input
15	RXD1	Input
16	RXD0	Input
18	CRS_DV	Input
19	REF_CLK	Input
20	RXER	Input
21	INTRP	Input
23	TXEN	Input
24	TXD0	Input
25	TXD1	Input
30	LED0	Input
31	LED1	Input
28	CONFIG0	Input
29	CONFIG1	Output

Table 8. NAND Tree Test Pin Order for KSZ8051RNLU

NAND Tree I/O Testing

Use the following procedure to check for faults on the KSZ8051MNLU/RNLU digital I/O pin connections to the board:

- 1. Enable NAND tree mode using either hardware (NAND Tree#, pin 21) or software (register 16h, bit [5]).
- 2. Use board logic to drive all KSZ8051MNLU/RNLU NAND tree input pins high.
- 3. Use board logic to drive each NAND tree input pin, in KSZ8051MNLU/RNLU NAND tree pin order, as follows:
 - a. Toggle the first pin (MDIO) from high to low, and verify that the CRS/CONFIG1 pin switches from high to low to indicate that the first pin is connected properly.
 - b. Leave the first pin (MDIO) low.
 - c. Toggle the second pin (MDC) from high to low, and verify that the CRS/CONFIG1 pin switches from low to high to indicate that the second pin is connected properly.
 - d. Leave the first pin (MDIO) and the second pin (MDC) low.
 - e. Toggle the third pin (RXD3/PHYAD0)) from high to low, and verify that the CRS/CONFIG1 pin switches from high to low to indicate that the third pin is connected properly.
 - f. Continue with this sequence until all KSZ8051MNLU/RNLU NAND tree input pins have been toggled.

Each KSZ8051MNLU/RNLU NAND tree input pin must cause the CRS/CONFIG1 output pin to toggle high-to-low or low-to-high to indicate a good connection. If the CRS pin fails to toggle when the KSZ8051MNLU/RNLU input pin toggles from high to low, the input pin has a fault.

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Power Management

The KSZ8051MNLU/RNLU incorporates a number of power-management modes and features that provide methods to consume less energy. These are discussed in the following sections.

Power-Saving Mode

Power-saving mode is used to reduce the transceiver power consumption when the cable is unplugged. It is enabled by writing a '1' to register 1Fh, bit [10], and is in effect when auto-negotiation mode is enabled and the cable is disconnected (no link).

In this mode, the KSZ8051MNLU/RNLU shuts down all transceiver blocks, except for the transmitter, energy detect, and PLL circuits.

By default, power-saving mode is disabled after power-up.

Energy-Detect Power-Down Mode

Energy-detect power-down (EDPD) mode is used to further reduce transceiver power consumption when the cable is unplugged. It is enabled by writing a '0' to register 18h, bit [11], and is in effect when auto-negotiation mode is enabled and the cable is disconnected (no link).

EDPD mode works with the PLL off (set by writing a '1' to register 10h, bit [4] to automatically turn the PLL off in EDPD mode) to turn off all KSZ8051MNLU/RNLU transceiver blocks except the transmitter and energy-detect circuits.

Power can be reduced further by extending the time interval between transmissions of link pulses to check for the presence of a link partner. The periodic transmission of link pulses is needed to ensure the KSZ8051MNLU/RNLU and its link partner, when operating in the same low-power state and with Auto MDI/MDI-X disabled, can wake up when the cable is connected between them.

By default, energy-detect power-down mode is disabled after power-up.

Power-Down Mode

Power-down mode is used to power down the KSZ8051MNLU/RNLU device when it is not in use after power-up. It is enabled by writing a '1' to register 0h, bit [11].

In this mode, the KSZ8051MNLU/RNLU disables all internal functions except the MII management interface. The KSZ8051MNLU/RNLU exits (disables) power-down mode after register 0h, bit [11] is set back to '0'.

Slow-Oscillator Mode

Slow-oscillator mode is used to disconnect the input reference crystal/clock on XI (pin 9) and select the on-chip slow oscillator when the KSZ8051MNLU/RNLU device is not in use after power-up. It is enabled by writing a '1' to register 11h, bit [5].

Slow-oscillator mode works in conjunction with power-down mode to put the KSZ8051MNLU/RNLU device in the lowest power state, with all internal functions disabled except the MII management interface. To properly exit this mode and return to normal PHY operation, use the following programming sequence:

- 1. Disable slow-oscillator mode by writing a '0' to register 11h, bit [5].
- 2. Disable power-down mode by writing a '0' to register 0h, bit [11].
- 3. Initiate software reset by writing a '1' to register 0h, bit [15].

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Reference Circuit for Power and Ground Connections

The KSZ8051MNLU/RNLU is a single 3.3V supply device with a built-in regulator to supply the 1.2V core. The power and ground connections are shown in Figure 10 and Table 9 for 3.3V VDDIO.

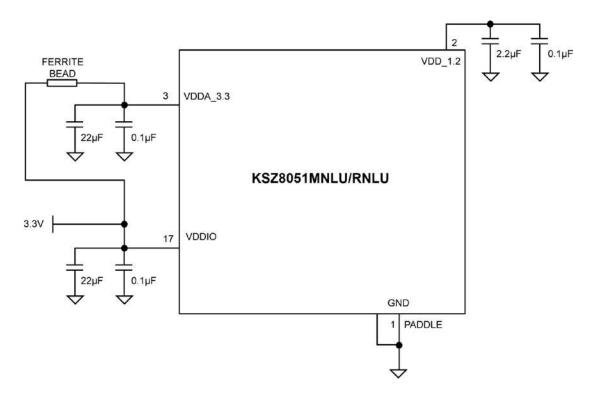


Figure 10. KSZ8051MNLU/RNLU Power and Ground Connections

Power Pin	Pin Number	Description
VDD_1.2	2	Decouple with 2.2µF and 0.1µF capacitors to ground.
VDDA 3.3	3	Connect to board's 3.3V supply through a ferrite bead.
VDDA_3.3		Decouple with 22µF and 0.1µF capacitors to ground.
VDDIO	17	Connect to board's 3.3V supply for 3.3V VDDIO.
VDDIO		Decouple with 22µF and 0.1µF capacitors to ground.

Table 9. KSZ8051MNLU/RNLU Power Pin Description

Typical Current/Power Consumption

Table 10 through Table 12 show typical values for current consumption by the transceiver (VDDA_3.3) and digital I/O (VDDIO) power pins and typical values for power consumption by the KSZ8051MNLU/RNLU device for the indicated nominal operating voltages. These current and power consumption values include the transmit driver current and on-chip regulator current for the 1.2V core.

Transceiver (3.3V), Digital I/Os (3.3V)

Condition	3.3V Transceiver (VDDA_3.3)	3.3V Digital I/Os (VDDIO)	Total Chip Power
	mA	mA	mW
100Base-TX Link-up (no traffic)	34	12	152
100Base-TX Full-duplex @ 100% utilization	34	13	155
10Base-T Link-up (no traffic)	14	11	82.5
10Base-T Full-duplex @ 100% utilization	30	11	135
Power-saving mode (Reg. 1Fh, bit [10] = 1)	14	10	79.2
EDPD mode (Reg. 18h, bit [11] = 0)	10	10	66.0
EDPD mode (Reg. 18h, bit [11] = 0) and PLL off (Reg. 10h, bit [4] = 1)	3.77	1.54	17.5
Software power-down mode (Reg. 0h, bit [11] =1)	2.59	1.51	13.5
Software power-down mode (Reg. 0h, bit [11] =1) and slow-oscillator mode (Reg. 11h, bit [5] =1)	1.36	0.45	5.97

Table 10. Typical Current/Power Consumption (VDDA_3.3 = 3.3V, VDDIO = 3.3V)

Transceiver (3.3V), Digital I/Os (2.5V)

Condition	3.3V Transceiver (VDDA_3.3)	2.5V Digital I/Os (VDDIO)	Total Chip Power
	mA	mA	mW
100Base-TX Link-up (no traffic)	34	11	140
100Base-TX Full-duplex @ 100% utilization	34	12	142
10Base-T Link-up (no traffic)	15	10	74.5
10Base-T Full-duplex @ 100% utilization	27	10	114
Power-saving mode (Reg. 1Fh, bit [10] = 1)	15	10	74.5
EDPD mode (Reg. 18h, bit [11] = 0)	11	10	61.3
EDPD mode (Reg. 18h, bit [11] = 0) and PLL off (Reg. 10h, bit [4] = 1)	3.55	1.35	15.1
Software power-down mode (Reg. 0h, bit [11] =1)	2.29	1.34	10.9
Software power-down mode (Reg. 0h, bit [11] =1) and slow-oscillator mode (Reg. 11h, bit [5] =1)	1.15	0.29	4.52

Table 11. Typical Current/Power Consumption (VDDA_3.3 = 3.3V, VDDIO = 2.5V)

Transceiver (3.3V), Digital I/Os (1.8V)

Condition	3.3V Transceiver (VDDA_3.3)	1.8V Digital I/Os (VDDIO)	Total Chip Power
	mA	mA	mW
100Base-TX Link-up (no traffic)	34	11	132
100Base-TX Full-duplex @ 100% utilization	34	12	134
10Base-T Link-up (no traffic)	15	9.0	65.7
10Base-T Full-duplex @ 100% utilization	27	9.0	105
Power-saving mode (Reg. 1Fh, bit [10] = 1)	15	9.0	65.7
EDPD mode (Reg. 18h, bit [11] = 0)	11	9.0	52.5
EDPD mode (Reg. 18h, bit [11] = 0) and PLL off (Reg. 10h, bit [4] = 1)	4.05	1.21	15.5
Software power-down mode (Reg. 0h, bit [11] =1)	2.79	1.21	11.4
Software power-down mode (Reg. 0h, bit [11] =1) and slow-oscillator mode (Reg. 11h, bit [5] =1)	1.65	0.19	5.79

Table 12. Typical Current/Power Consumption (VDDA_3.3 = 3.3V, VDDIO = 1.8V)

Register Map

Register Number (Hex)	Description
0h	Basic Control
1h	Basic Status
2h	PHY Identifier 1
3h	PHY Identifier 2
4h	Auto-Negotiation Advertisement
5h	Auto-Negotiation Link Partner Ability
6h	Auto-Negotiation Expansion
7h	Auto-Negotiation Next Page
8h	Link Partner Next Page Ability
9h	Reserved
10h	Digital Reserved Control
11h	AFE Control 1
12h – 14h	Reserved
15h	RXER Counter
16h	Operation Mode Strap Override
17h	Operation Mode Strap Status
18h	Expanded Control
19h – 1Ah	Reserved
1Bh	Interrupt Control/Status
1Ch	Reserved
1Dh	LinkMD Control/Status
1Eh	PHY Control 1
1Fh	PHY Control 2

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Register Description

Address	Name	Description	Mode ⁽¹⁾	Default
Register 0h -	- Basic Control			
0.15	Reset	1 = Software reset	RW/SC	0
		0 = Normal operation		
		This bit is self-cleared after a '1' is written to it.		
0.14	Loopback	1 = Loopback mode	RW	0
		0 = Normal operation		
0.13	Speed Select	1 = 100Mbps	RW	Set by the SPEED strapping pin.
		0 = 10Mbps		See the "Strapping Options"
		This bit is ignored if auto-negotiation is enabled (register $0.12 = 1$).		section for details.
0.12	Auto-	1 = Enable auto-negotiation process	RW	Set by the NWAYEN strapping
	Negotiation Enable	0 = Disable auto-negotiation process		pin.
		If enabled, the auto-negotiation result overrides the settings in registers 0.13 and 0.8.		See the "Strapping Options" section for details.
0.11	Power-Down	1 = Power-down mode	RW	0
		0 = Normal operation		
		If software reset (register 0.15) is used to exit power-down mode (register 0.11 = 1), two software reset writes (register 0.15 = 1) are required. The first write clears power-down mode; the second write resets the chip and relatches the pin strapping pin values.		
0.10	Isolate	1 = Electrical isolation of PHY from MII/RMII	RW	Set by the ISO strapping pin.
		0 = Normal operation		See the "Strapping Options" section for details.
0.9	Restart Auto-	1 = Restart auto-negotiation process	RW/SC	0
	Negotiation	0 = Normal operation.		
		This bit is self-cleared after a '1' is written to it.		
0.8	Duplex Mode	1 = Full-duplex	RW	The inverse of the DUPLEX
		0 = Half-duplex		strapping pin value.
				See the "Strapping Options" section for details.
0.7	Collision Test	1 = Enable COL test	RW	0
		0 = Disable COL test		
0.6:0	Reserved	Reserved	RO	000_0000
Register 1h -	- Basic Status			
1.15	100Base-T4	1 = T4 capable	RO	0
		0 = Not T4 capable		
1.14	100Base-TX	1 = Capable of 100Mbps full-duplex	RO	1
	Full-Duplex	0 = Not capable of 100Mbps full-duplex		
1.13	100Base-TX	1 = Capable of 100Mbps half-duplex	RO	1
	Half-Duplex	0 = Not capable of 100Mbps half-duplex		
1.12	10Base-T	1 = Capable of 10Mbps full-duplex	RO	1
	Full-Duplex	0 = Not capable of 10Mbps full-duplex		

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Address	Name	Description	Mode ⁽¹⁾	Default
1.11	10Base-T	1 = Capable of 10Mbps half-duplex	RO	1
	Half-Duplex	0 = Not capable of 10Mbps half-duplex		
1.10:7	Reserved	Reserved	RO	000_0
1.6	No Preamble	1 = Preamble suppression	RO	1
		0 = Normal preamble		
1.5	Auto-	1 = Auto-negotiation process completed	RO	0
	Negotiation Complete	0 = Auto-negotiation process not completed		
1.4	Remote Fault	1 = Remote fault	RO/LH	0
		0 = No remote fault		
1.3	Auto-	1 = Can perform auto-negotiation	RO	1
	Negotiation Ability	0 = Cannot perform auto-negotiation		
1.2	Link Status	1 = Link is up	RO/LL	0
		0 = Link is down		
1.1	Jabber Detect	1 = Jabber detected	RO/LH	0
		0 = Jabber not detected (default is low)		
1.0	Extended Capability	1 = Supports extended capability registers	RO	1
Register 2h	– PHY Identifier 1		.	
2.15:0	PHY ID Number	Assigned to the 3rd through 18th bits of the Organizationally Unique Identifier (OUI). KENDIN Communication's OUI is 0010A1 (hex).	RO	0022h
Register 3h	– PHY Identifier 2		•	
3.15:10	PHY ID Number	Assigned to the 19th through 24th bits of the Organizationally Unique Identifier (OUI). KENDIN Communication's OUI is 0010A1 (hex).	RO	0001_01
3.9:4	Model Number	Six-bit manufacturer's model number	RO	01_0110
3.3:0	Revision Number	Four-bit manufacturer's revision number	RO	Indicates silicon revision
Register 4h	– Auto-Negotiatio	n Advertisement		
4.15	Next Page	1 = Next page capable	RW	0
		0 = No next page capability		
4.14	Reserved	Reserved	RO	0
4.13	Remote Fault	1 = Remote fault supported	RW	0
		0 = No remote fault		
4.12	Reserved	Reserved	RO	0
4.11:10	Pause	[00] = No pause	RW	00
		[10] = Asymmetric pause		
		[01] = Symmetric pause		
		[11] = Asymmetric and symmetric pause		
4.9	100Base-T4	1 = T4 capable	RO	0
		0 = No T4 capability		

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Address	Name	Description	Mode ⁽¹⁾	Default
4.8	100Base-TX	1 = 100Mbps full-duplex capable	RW	Set by the SPEED strapping pin.
	Full-Duplex	0 = No 100Mbps full-duplex capability		See the "Strapping Options" section for details.
4.7	100Base-TX	1 = 100Mbps half-duplex capable	RW	Set by the SPEED strapping pin.
	Half-Duplex	0 = No 100Mbps half-duplex capability		See the "Strapping Options" section for details.
4.6	10Base-T	1 = 10Mbps full-duplex capable	RW	1
	Full-Duplex	0 = No 10Mbps full-duplex capability		
4.5	10Base-T	1 = 10Mbps half-duplex capable	RW	1
	Half-Duplex	0 = No 10Mbps half-duplex capability		
4.4:0	Selector Field	[00001] = IEEE 802.3	RW	0_0001
Register 5h	– Auto-Negotiatio	n Link Partner Ability		
5.15	Next Page	1 = Next page capable	RO	0
		0 = No next page capability		
5.14	Acknowledge	1 = Link code word received from partner	RO	0
		0 = Link code word not yet received		
5.13	Remote Fault	1 = Remote fault detected	RO	0
		0 = No remote fault		
5.12	Reserved	Reserved	RO	0
5.11:10	Pause	[00] = No pause	RO	00
		[10] = Asymmetric pause		
		[01] = Symmetric pause		
		[11] = Asymmetric and symmetric pause		
5.9	100Base-T4	1 = T4 capable	RO	0
		0 = No T4 capability		
5.8	100Base-TX	1 = 100Mbps full-duplex capable	RO	0
	Full-Duplex	0 = No 100Mbps full-duplex capability		
	100Base-TX	1 = 100Mbps half-duplex capable	RO	0
	Half-Duplex	0 = No 100Mbps half-duplex capability		
5.6	10Base-T	1 = 10Mbps full-duplex capable	RO	0
	Full-Duplex	0 = No 10Mbps full-duplex capability		
5.5	10Base-T	1 = 10Mbps half-duplex capable	RO	0
	Half-Duplex	0 = No 10Mbps half-duplex capability		
5.4:0	Selector Field	[00001] = IEEE 802.3	RO	0_0001
Register 6h	– Auto-Negotiatio	n Expansion		1
6.15:5	Reserved	Reserved	RO	0000_0000_000
6.4	Parallel	1 = Fault detected by parallel detection	RO/LH	0
	Detection Fault	0 = No fault detected by parallel detection		
6.3	Link Partner	1 = Link partner has next page capability	RO	0
	Next Page Able	0 = Link partner does not have next page capability		
6.2	Next Page	1 = Local device has next page capability	RO	1
	Able	0 = Local device does not have next page capability		

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Address	Name	Description	Mode ⁽¹⁾	Default
6.1	Page Received	1 = New page received	RO/LH	0
		0 = New page not received yet		
6.0	Link Partner	1 = Link partner has auto-negotiation capability	RO	0
	Auto- Negotiation Able	0 = Link partner does not have auto-negotiation capability		
Register 7h	– Auto-Negotiatio	n Next Page		
7.15	Next Page	1 = Additional next pages will follow	RW	0
		0 = Last page		
7.14	Reserved	Reserved	RO	0
7.13	Message Page	1 = Message page	RW	1
		0 = Unformatted page		
7.12	Acknowledge2	1 = Will comply with message	RW	0
		0 = Cannot comply with message		
7.11	Toggle	1 = Previous value of the transmitted link code word equaled logic 1	RO	0
		0 = Logic 0		
7.10:0	Message Field	11-bit field to encode 2048 messages	RW	000_0000_0001
Register 8h	– Link Partner Nex	t Page Ability		
8.15	Next Page	1 = Additional next pages will follow	RO	0
		0 = Last page		
8.14	Acknowledge	1 = Successful receipt of link word	RO	0
		0 = No successful receipt of link word		
8.13	Message Page	1 = Message page	RO	0
		0 = Unformatted page		
8.12	Acknowledge2	1 = Can act on the information	RO	0
		0 = Cannot act on the information		
8.11	Toggle 1 = Previous value of transmitted link code word equal to logic 0	RO	0	
		0 = Previous value of transmitted link code word equal to logic 1		
8.10:0	Message Field	11-bit field to encode 2048 messages	RO	000_0000_0000
Register 10	h – Digital Reserve	d Control		
10.15:5	Reserved	Reserved	RW	0000_0000_000
10.4	PLL Off	1 = Turn PLL off automatically in EDPD mode		
		0 = Keep PLL on in EDPD mode.	RW	0
		See also register 18h, bit [11] for EDPD mode		
10.3:0	Reserved	Reserved	RW	0000
Register 11	h – AFE Control 1			
11.15:6	Reserved	Reserved	RW	0000_0000_00

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Address	Name	Description	Mode ⁽¹⁾	Default
11.5	Slow-Oscillator Mode Enable	Slow-oscillator mode is used to disconnect the input reference crystal/clock on the XI pin and select the on-chip slow oscillator when the KSZ8051MNLU/RNLU device is not in use after power-up. 1 = Enable 0 = Disable This bit automatically sets software power-down to the analog side when enabled.	RW	0
11.4:0	Reserved	Reserved	RW	0_0000
Register 15h	- RXER Counter			
15.15:0	RXER Counter	Receive error counter for symbol error frames	RO/SC	0000h
	- Operation Mod	•	11117	
16.15:11	Reserved	Reserved	RW	0000_0
16.10	Reserved	Reserved	RO	0
16.9	B-CAST_OFF	1 = Override strap-in for B-CAST_OFF	RW	0
10.0	Override	If bit is '1', PHY Address 0 is non-broadcast.	1000	
16.8	Reserved	Reserved	RW	0
16.7	MII B-to-B Override	1 = Override strap-in for MII back-to-back mode (also set bit 0 of this register to '1')	RW	0
40.0	DMII D to D	This bit applies only to KSZ8051MNLU.	DW	
16.6	RMII B-to-B Override	1 = Override strap-in for RMII Back-to-Back mode (also set bit 1 of this register to '1')	RW	0
40.5	NAND To -	This bit applies only to KSZ8051RNLU.	DW	
16.5	NAND Tree Override	1 = Override strap-in for NAND tree mode	RW	0
16.4:2	Reserved	Reserved	RW	0_00
16.1	RMII Override	1 = Override strap-in for RMII mode This bit applies only to KSZ8051RNLU.	RW	0
16.0	MII Override	1 = Override strap-in for MII mode	RW	1
		This bit applies only to KSZ8051MNLU.		
Register 17h	- Operation Mod	e Strap Status		
17.15:13	PHYAD[2:0]	[000] = Strap to PHY Address 0	RO	
	Strap-In Status	[001] = Strap to PHY Address 1		
		[010] = Strap to PHY Address 2		
		[011] = Strap to PHY Address 3		
		[100] = Strap to PHY Address 4		
		[101] = Strap to PHY Address 5		
		[110] = Strap to PHY Address 6		
		[111] = Strap to PHY Address 7		
17.12:10	Reserved	Reserved	RO	
17.9	B-CAST_OFF	1 = Strap to B-CAST_OFF	RO	
	Strap-In Status	If bit is '1', PHY Address 0 is non-broadcast.		
17.8	Reserved	Reserved	RO	

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to MII back-to-back mode pplies only to KSZ8051MNLU. to RMII Back-to-Back mode pplies only to KSZ8051RNLU. to NAND tree mode to RMII mode pplies only to KSZ8051RNLU. to MII mode pplies only to KSZ8051MNLU. etect power-down mode le e register 10h, bit [4] for PLL off.	RO RO RO RO RO RO RO RO	0000
to RMII Back-to-Back mode pplies only to KSZ8051RNLU. to NAND tree mode to RMII mode pplies only to KSZ8051RNLU. to MII mode pplies only to KSZ8051MNLU. etect power-down mode le le register 10h, bit [4] for PLL off.	RO RO RO RO	
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to NAND tree mode to RMII mode pplies only to KSZ8051RNLU. to MII mode pplies only to KSZ8051MNLU. etect power-down mode le le register 10h, bit [4] for PLL off.	RO RO RO	
to RMII mode pplies only to KSZ8051RNLU. to MII mode pplies only to KSZ8051MNLU. etect power-down mode le e register 10h, bit [4] for PLL off.	RO RO RO	
to RMII mode pplies only to KSZ8051RNLU. to MII mode pplies only to KSZ8051MNLU. etect power-down mode le e register 10h, bit [4] for PLL off.	RO RO	
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to MII mode pplies only to KSZ8051MNLU. etect power-down mode le e register 10h, bit [4] for PLL off.	RW	
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etect power-down mode le e register 10h, bit [4] for PLL off.		
etect power-down mode le e register 10h, bit [4] for PLL off.		
etect power-down mode le e register 10h, bit [4] for PLL off.		
le e register 10h, bit [4] for PLL off.	RW	1
le e register 10h, bit [4] for PLL off.		
register 10h, bit [4] for PLL off.		
Ithut is random latency		
riput is random latently	RW	0
utput is fixed latency		
settings, all bytes of received preamble ed to the MII output.		
oplies only to KSZ8051MNLU.		
	RW	00_0
re received preamble to MII output	RW	0
ove all seven bytes of preamble before ing frame (starting with SFD) to MII ut		
oplies only to KSZ8051MNLU		
	RW	00_0000
e jabber interrupt	RW	0
le jabber interrupt		
a receive error interrupt	RW	0
e receive error interrupt le receive error interrupt	KVV	0
le receive error interrupt		
e page received interrupt	RW	0
le page received interrupt		
io pago rocorrod interrupt	RW	0
e parallel detect fault interrupt	RW	0
ı	ole page received interrupt ole page received interrupt ole parallel detect fault interrupt ole parallel detect fault interrupt	ole page received interrupt RW ole page received interrupt ole parallel detect fault interrupt RW

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Address	Name	Description	Mode ⁽¹⁾	Default
1B.10	Link-Down Interrupt Enable	1= Enable link-down interrupt 0 = Disable link-down interrupt	RW	0
1B.9	Remote Fault Interrupt Enable	1 = Enable remote fault interrupt 0 = Disable remote fault interrupt	RW	0
1B.8	Link-Up Interrupt Enable	1 = Enable link-up interrupt 0 = Disable link-up interrupt	RW	0
1B.7	Jabber Interrupt	1 = Jabber occurred 0 = Jabber did not occur	RO/SC	0
1B.6	Receive Error Interrupt	1 = Receive error occurred 0 = Receive error did not occur	RO/SC	0
1B.5	Page Receive Interrupt	1 = Page receive occurred 0 = Page receive did not occur	RO/SC	0
1B.4	Parallel Detect Fault Interrupt	1 = Parallel detect fault occurred 0 = Parallel detect fault did not occur	RO/SC	0
1B.3	Link Partner Acknowledge Interrupt	1 = Link partner acknowledge occurred 0 = Link partner acknowledge did not occur	RO/SC	0
1B.2	Link-Down Interrupt	1 = Link-down occurred 0 = Link-down did not occur	RO/SC	0
1B.1	Remote Fault Interrupt	1 = Remote fault occurred 0 = Remote fault did not occur	RO/SC	0
1B.0	Link-Up Interrupt	1 = Link-up occurred 0 = Link-up did not occur	RO/SC	0
Register 1Dh	- LinkMD Contro	ol/Status		
1D.15	Cable Diagnostic Test Enable	 1 = Enable cable diagnostic test. After test has completed, this bit is self-cleared. 0 = Indicates cable diagnostic test (if enabled) has completed and the status information is valid for read. 	RW/SC	0
1D.14:13	Cable Diagnostic Test Result	 [00] = Normal condition [01] = Open condition has been detected in cable [10] = Short condition has been detected in cable [11] = Cable diagnostic test has failed 	RO	00
1D.12	Short Cable Indicator	1 = Short cable (<10 meter) has been detected by LinkMD	RO	0
1D.11:9	Reserved	Reserved	RW	000
1D.8:0	Cable Fault Counter	Distance to fault	RO	0_0000_0000
Register 1Eh	- PHY Control 1		<u> </u>	.
1E.15:10	Reserved	Reserved	RO	0000_00
1E.9	Enable Pause (Flow Control)	1 = Flow control capable 0 = No flow control capability	RO	0

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Address	Name	Description	Mode ⁽¹⁾	Default
1E.8	Link Status	1 = Link is up	RO	0
		0 = Link is down		
1E.7	Polarity Status	1 = Polarity is reversed	RO	
		0 = Polarity is not reversed		
1E.6	Reserved	Reserved	RO	0
1E.5	MDI/MDI-X	1 = MDI-X	RO	
	State	0 = MDI		
1E.4	Energy Detect	1 = Signal present on receive differential pair	RO	0
		0 = No signal detected on receive differential pair		
1E.3	PHY Isolate	1 = PHY in isolate mode	RW	0
		0 = PHY in normal operation		
1E.2:0	Operation	[000] = Still in auto-negotiation	RO	000
	Mode Indication	[001] = 10Base-T half-duplex		
	maication	[010] = 100Base-TX half-duplex		
		[011] = Reserved		
		[100] = Reserved		
		[101] = 10Base-T full-duplex		
		[110] = 100Base-TX full-duplex		
		[111] = Reserved		
Register 1Fh	- PHY Control 2			
1F.15	HP_MDIX	1 = HP Auto MDI/MDI-X mode	RW	1
		0 = Micrel Auto MDI/MDI-X mode		
1F.14	.14 MDI/MDI-X Select	When Auto MDI/MDI-X is disabled,	RW	0
		1 = MDI-X mode		
		Transmit on RXP,RXM (pins 5, 4) and Receive on TXP,TXM (pins 7, 6)		
		0 = MDI mode		
		Transmit on TXP,TXM (pins 7, 6) and Receive on RXP,RXM (pins 5, 4)		
1F.13	Pair Swap	1 = Disable Auto MDI/MDI-X	RW	0
	Disable	0 = Enable Auto MDI/MDI-X		
1F.12	Reserved	Reserved	RW	0
1F.11	Force Link	1 = Force link pass	RW	0
		0 = Normal link operation		
		This bit bypasses the control logic and allows the transmitter to send a pattern even if there is no link.		
1F.10	Power Saving	1 = Enable power saving	RW	0
		0 = Disable power saving		
1F.9	Interrupt Level	1 = Interrupt pin active high	RW	0
		0 = Interrupt pin active low		
1F.8	Enable Jabber	1 = Enable jabber counter	RW	1
		0 = Disable jabber counter		

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Address	Name	Description	Mode ⁽¹⁾	Default
1F.7	RMII Reference	1 = RMII 50MHz clock mode; clock input to XI (pin 9) is 50MHz	RW	0
	Clock Select	0 = RMII 25MHz clock mode; clock input to XI (pin 9) is 25MHz		
		This bit applies only to KSZ8051RNLU.		
1F.6	Reserved	Reserved	RW	0
1F.5:4	LED Mode	[00] = LED1: Speed	RW	00
1F.3	Disable Transmitter	1 = Disable transmitter 0 = Enable transmitter	RW	0
1F.2	Remote Loopback	1 = Remote (analog) loopback is enabled 0 = Normal mode	RW	0
1F.1	Enable SQE Test	1 = Enable SQE test 0 = Disable SQE test	RW	0
1F.0	Disable Data Scrambling	1 = Disable scrambler 0 = Enable scrambler	RW	0

Note:

1. RW = Read/Write.

RO = Read only.

SC = Self-cleared.

LH = Latch high.

LL = Latch low.

Absolute Maximum Ratings(1)

Operating Ratings⁽²⁾

Supply Voltage
(V _{DDIO 3.3,} V _{DDA 3.3})+3.135V to +3.465V
(V _{DDIO 2.5})+2.375V to +2.625V
(V _{DDIO_1.8})+1.710V to +1.890V
Ambient Temperature
(T _A , Automotive Qualified)40°C to +85°C
Maximum Junction Temperature (T₁max.)125°C
Thermal Resistance (θ _{JA})34°C/W
Thermal Resistance (θ_{IC})6°C/W

Electrical Characteristics(3)

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
Supply C	urrent (V _{DDIO} , V _{DDA_3.3} = 3.3V) ⁽⁴⁾					
I _{DD1_3.3V}	10Base-T	Full-duplex traffic @ 100% utilization		41		mA
I _{DD2_3.3V}	100Base-TX	Full-duplex traffic @ 100% utilization		47		mA
I _{DD3_3.3V}	EDPD Mode	Ethernet cable disconnected (reg. 18h.11 = 0)		20		mA
I _{DD4_3.3V}	Power-Down Mode	Software power-down (reg. 0h.11 = 1)		4		mA
CMOS Le	vel Inputs					
		$V_{DDIO} = 3.3V$	2.0			V
V _{IH}	Input High Voltage	V _{DDIO} = 2.5V	1.8			V
		$V_{DDIO} = 1.8V$	1.3			V
		$V_{DDIO} = 3.3V$			0.8	V
V_{IL}	Input Low Voltage	V _{DDIO} = 2.5V			0.7	V
		V _{DDIO} = 1.8V			0.5	V
I _{IN}	Input Current	V _{IN} = GND ~ VDDIO			10	μΑ
CMOS Le	vel Outputs	·				
		$V_{DDIO} = 3.3V$	2.4			V
V_{OH}	Output High Voltage	V _{DDIO} = 2.5V	2.0			V
		$V_{DDIO} = 1.8V$	1.5			V
		$V_{DDIO} = 3.3V$			0.4	V
V_{OL}	Output Low Voltage	V _{DDIO} = 2.5V			0.4	V
		V _{DDIO} = 1.8V			0.3	V
I _{oz}	Output Tri-State Leakage				10	μΑ
LED Outp	out					
I _{LED}	Output Drive Current	Each LED pin (LED0, LED1)		8		mA

Notes:

- 1. Exceeding the absolute maximum rating can damage the device. Stresses greater than the absolute maximum rating can cause permanent damage to the device. Operation of the device at these or any other conditions above those specified in the operating sections of this specification is not implied. Maximum conditions for extended periods may affect reliability.
- 2. The device is not guaranteed to function outside its operating rating.
- 3. $T_A = 25$ °C. Specification is for packaged product only.
- Current consumption is for the single 3.3V supply KSZ8051MNLU/RNLU device only, and includes the transmit driver current and the 1.2V supply voltage (V_{DD_1.2}) that are supplied by the KSZ8051MNLU/RNLU.

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Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
All Pull-U	p/Pull-Down Pins (including Strap	pping Pins)				
		$V_{DDIO} = 3.3V$	30	45	73	kΩ
pu	Internal Pull-Up Resistance	V _{DDIO} = 2.5V	39	61	102	kΩ
		V _{DDIO} = 1.8V	48	99	178	kΩ
		V _{DDIO} = 3.3V	26	43	79	kΩ
pd	Internal Pull-Down Resistance	V _{DDIO} = 2.5V	34	59	113	kΩ
		V _{DDIO} = 1.8V	53	99	200	kΩ
100Base-	TX Transmit (measured differentia	ally after 1:1 transformer)				
Vo	Peak Differential Output Voltage	100Ω termination across differential output	0.95		1.05	V
V _{IMB}	Output Voltage Imbalance	100Ω termination across differential output			2	%
t _r , t _f	Rise/Fall Time		3		5	ns
	Rise/Fall Time Imbalance		0		0.5	ns
	Duty Cycle Distortion				±0.25	ns
	Overshoot				5	%
	Output Jitter	Peak-to-peak		0.7		ns
10Base-T	Transmit (measured differentially	<i>ı</i> after 1:1 transformer)				
V _P	Peak Differential Output Voltage	100Ω termination across differential output	2.2		2.8	V
	Jitter Added	Peak-to-peak			3.5	ns
t _r , t _f	Rise/Fall Time			25		ns
10Base-T	Receive			l.		
V _{SQ}	Squelch Threshold	5MHz square wave		400		mV
Transmitt	er – Drive Setting					
V _{SET}	Reference Voltage of I _{SET}	$R(I_{SET}) = 6.49k\Omega$		0.65		V
REF CLK	Output			l .	l	l
	50MHz RMII Clock Output Jitter	Peak-to-peak		300		ps
	,	(Applies only to KSZ8051RNLU in RMII – 25MHz clock mode)				
100Mbps	Mode – Industrial Applications Pa	arameters		•		
	Clock Phase Delay – XI Input to MII TXC Output	XI (25MHz clock input) to MII TXC (25MHz clock output) delay, referenced to rising edges of both clocks.	15	20	25	ns
		(Applies only to KSZ8051MNLU in MII mode)				
t _{IIr}	Link Loss Reaction (Indication) Time	Link loss detected at receive differential inputs to PHY signal indication time for each of the following:		4.4		μs
		1. For LED mode 00, Speed LED output changes from low (100Mbps) to high (10Mbps, default state for link-down).				
		2. For LED mode 01, Link LED output changes from low (link-up) to high (link-down).				
		INTRP pin asserts for link-down status change.				

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Timing Diagrams

MII SQE Timing (10Base-T)

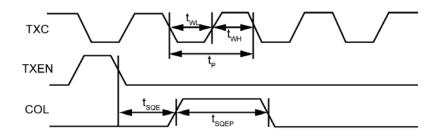


Figure 11. MII SQE Timing (10Base-T)

Timing Parameter	Description	Min.	Тур.	Max.	Unit
t _P	TXC period		400		ns
t _{WL}	TXC pulse width low		200		ns
t _{WH}	TXC pulse width high		200		ns
t _{SQE}	COL (SQE) delay after TXEN de-asserted		2.2		μs
t _{SQEP}	COL (SQE) pulse duration		1.0		μs

Table 13. MII SQE Timing (10Base-T) Parameters

MII Transmit Timing (10Base-T)

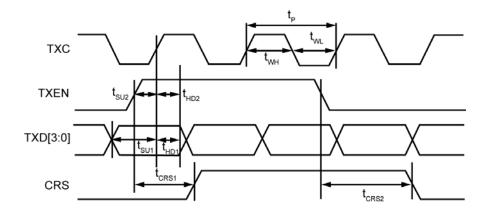


Figure 12. MII Transmit Timing (10Base-T)

Timing Parameter	Description	Min.	Тур.	Max.	Unit
t _P	TXC period		400		ns
t _{WL}	TXC pulse width low		200		ns
t _{WH}	TXC pulse width high		200		ns
t _{SU1}	TXD[3:0] setup to rising edge of TXC	120			ns
t _{SU2}	TXEN setup to rising edge of TXC	120			ns
t _{HD1}	TXD[3:0] hold from rising edge of TXC	0			ns
t _{HD2}	TXEN hold from rising edge of TXC	0			ns
t _{CRS1}	TXEN high to CRS asserted latency		600		ns
t _{CRS2}	TXEN low to CRS de-asserted latency		1.0		μs

Table 14. MII Transmit Timing (10Base-T) Parameters

MII Receive Timing (10Base-T)

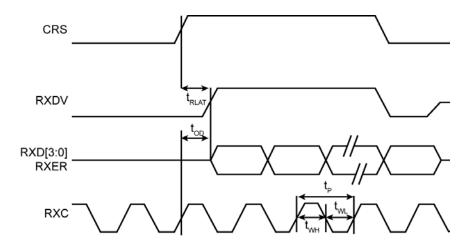


Figure 13. MII Receive Timing (10Base-T)

Timing Parameter	Description	Min.	Тур.	Max.	Unit
t _P	RXC period		400		ns
t _{WL}	RXC pulse width low		200		ns
t _{WH}	RXC pulse width high		200		ns
t _{OD}	(RXDV, RXD[3:0], RXER) output delay from rising edge of RXC		205		ns
t _{RLAT}	CRS to (RXDV, RXD[3:0]) latency		7.2		μs

Table 15. MII Receive Timing (10Base-T) Parameters

MII Transmit Timing (100Base-TX)

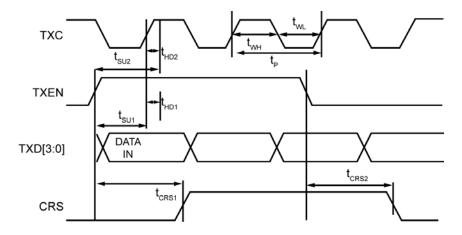


Figure 14. MII Transmit Timing (100Base-TX)

Timing Parameter	Description	Min.	Тур.	Max.	Unit
t _P	TXC period		40		ns
t _{WL}	TXC pulse width low		20		ns
t _{WH}	TXC pulse width high		20		ns
t _{SU1}	TXD[3:0] setup to rising edge of TXC	10			ns
t _{SU2}	TXEN setup to rising edge of TXC	10			ns
t _{HD1}	TXD[3:0] hold from rising edge of TXC	0			ns
t _{HD2}	TXEN hold from rising edge of TXC	0			ns
t _{CRS1}	TXEN high to CRS asserted latency		72		ns
t _{CRS2}	TXEN low to CRS de-asserted latency		72		ns

Table 16. MII Transmit Timing (100Base-TX) Parameters

MII Receive Timing (100Base-TX)

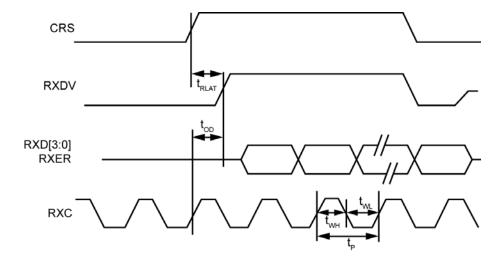


Figure 15. MII Receive Timing (100Base-TX)

Timing Parameter	Description	Min.	Тур.	Max.	Unit
t _P	RXC period		40		ns
t _{WL}	RXC pulse width low		20		ns
t _{WH}	RXC pulse width high		20		ns
t _{OD}	(RXDV, RXD[3:0], RXER) output delay from rising edge of RXC		25		ns
t _{RLAT}	CRS to (RXDV, RXD[3:0]) latency		170		ns

Table 17. MII Receive Timing (100Base-TX) Parameters

RMII Timing

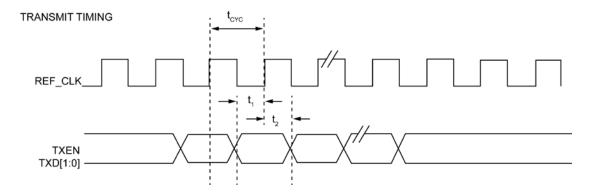


Figure 16. RMII Timing - Data Received from RMII

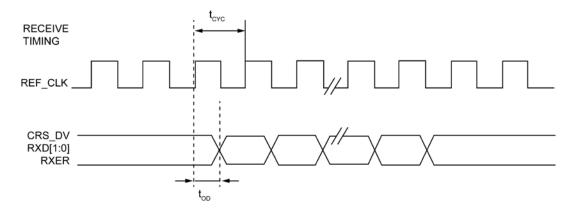


Figure 17. RMII Timing - Data Input to RMII

Timing Parameter	Description	Min.	Тур.	Max.	Unit
t _{CYC}	Clock cycle		20		ns
t ₁	Setup time	4			ns
t ₂	Hold time	2			ns
t _{OD}	Output delay	7	10	13	ns

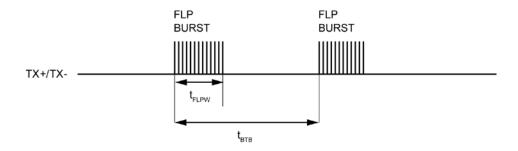
Table 18. RMII Timing Parameters – KSZ8051RNLU (25MHz input to XI pin, 50MHz output from REF_CLK pin)

Timing Parameter	Description	Min.	Тур.	Max.	Unit
tcyc	Clock cycle		20		ns
t ₁	Setup time	4			ns
t ₂	Hold time	2			ns
t _{OD}	Output delay	8	11	13	ns

Table 19. RMII Timing Parameters – KSZ8051RNLU (50MHz input to XI pin)

Auto-Negotiation Timing

AUTO -NEGOTIATION FAST LINK PULSE (FLP) TIMING



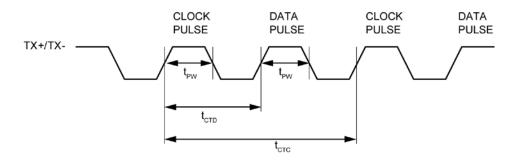


Figure 18. Auto-Negotiation Fast Link Pulse (FLP) Timing

Timing Parameter	Description	Min.	Тур.	Max.	Units
t _{BTB}	FLP burst to FLP burst	8	16	24	ms
t _{FLPW}	FLP burst width		2		ms
t _{PW}	Clock/Data pulse width		100		ns
t _{CTD}	Clock pulse to data pulse	55.5	64	69.5	μs
t _{CTC}	Clock pulse to clock pulse	111	128	139	μs
	Number of clock/data pulses per FLP burst	17		33	

Table 20. Auto-Negotiation Fast Link Pulse (FLP) Timing Parameters

MDC/MDIO Timing

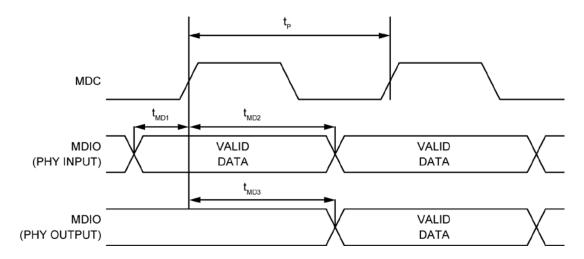


Figure 19. MDC/MDIO Timing

Timing Parameter	Description	Min.	Тур.	Max.	Unit
t _P	MDC period		400		ns
t _{MD1}	MDIO (PHY input) setup to rising edge of MDC	10			ns
t _{MD2}	MDIO (PHY input) hold from rising edge of MDC	4			ns
t _{MD3}	MDIO (PHY output) delay from rising edge of MDC	5			ns

Table 21. MDC/MDIO Timing Parameters

Power-Up/Reset Timing

The KSZ8051MNLU/RNLU reset timing requirement is summarized in Figure 20 and Table 22.

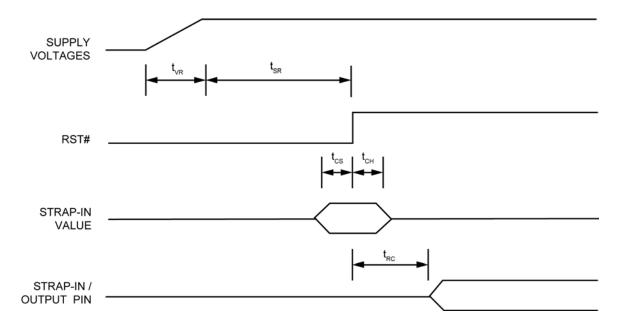


Figure 20. Power-Up/Reset Timing

Parameter	Description	Min.	Max.	Units
t _{VR}	Supply voltage (V _{DDIO} , V _{DDA_3.3}) rise time	300		μs
t _{SR}	Stable supply voltage (V _{DDIO} , V _{DDA_3.3}) to reset high	10		ms
t _{CS}	Configuration setup time	5		ns
t _{CH}	Configuration hold time	5		ns
t _{RC}	Reset to strap-in pin output	6		ns

Table 22. Power-Up/Reset Timing Parameters

The supply voltage (V_{DDIO} and $V_{DDA_3.3}$) power-up waveform should be monotonic. The 300 μ s minimum rise time is from 10% to 90%.

For warm reset, the reset (RST#) pin should be asserted low for a minimum of 500µs. The strap-in pin values are read and updated at the de-assertion of reset.

After the de-assertion of reset, wait a minimum of 100µs before starting programming on the MIIM (MDC/MDIO) interface.

Reset Circuit

Figure 21 shows a reset circuit recommended for powering up the KSZ8051MNLU/RNLU if reset is triggered by the power supply.

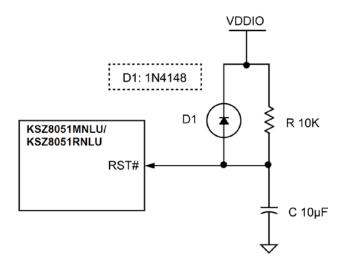


Figure 21. Recommended Reset Circuit

Figure 22 shows a reset circuit recommended for applications where reset is driven by another device (for example, the CPU or an FPGA). At power-on-reset, R, C, and D1 provide the necessary ramp rise time to reset the KSZ8051MNLU/RNLU device. The RST_OUT_N from the CPU/FPGA provides the warm reset after power-up.

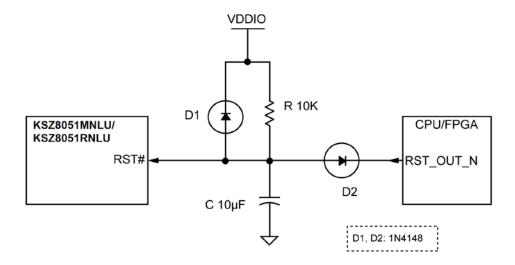
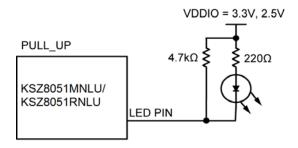
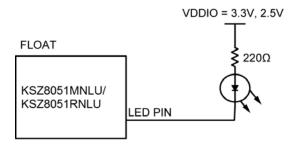


Figure 22. Recommended Reset Circuit for Interfacing with CPU/FPGA Reset Output

Reference Circuits - LED Strap-In Pins

The pull-up, float, and pull-down reference circuits for the LED1/SPEED and LED0/NWAYEN strapping pins are shown in Figure 23 for 3.3V and 2.5V VDDIO.





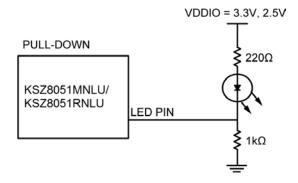


Figure 23. Reference Circuits for LED Strapping Pins

For 1.8V VDDIO, LED indication support is not recommended due to the low voltage. Without the LED indicator, the SPEED and NWAYEN strapping pins are functional with a $4.7k\Omega$ pull-up to 1.8V VDDIO or float for a value of '1', and with a $1.0k\Omega$ pull-down to ground for a value of '0'.

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Reference Clock - Connection and Selection

A crystal or external clock source, such as an oscillator, is used to provide the reference clock for the KSZ8051MNLU/RNLU. For the KSZ8051MNLU in all operating modes and for the KSZ8051RNLU in RMII – 25MHz Clock Mode, the reference clock is 25 MHz. The reference clock connections to XI (pin 9) and XO (pin 8), and the reference clock selection criteria, are provided in Figure 24 and Table 23.

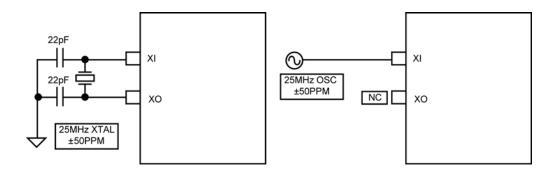


Figure 24. 25MHz Crystal/Oscillator Reference Clock Connection

Characteristics	Value	Units
Frequency	25	MHz
Frequency tolerance (max.)	±50	ppm

Table 23. 25MHz Crystal / Reference Clock Selection Criteria

For the KSZ8051RNLU in RMII – 50MHz clock mode, the reference clock is 50MHz. The reference clock connections to XI (pin 9), and the reference clock selection criteria are provided in Figure 25 and Table 24.

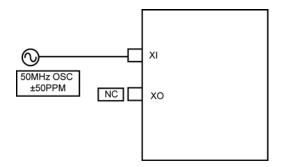


Figure 25. 50MHz Oscillator Reference Clock Connection

Characteristics	Value	Units
Frequency	50	MHz
Frequency tolerance (max)	±50	ppm

Table 24. 50MHz Oscillator / Reference Clock Selection Criteria

Magnetics - Connection and Selection

A 1:1 isolation transformer is required at the line interface. Use one with integrated common-mode chokes for designs exceeding FCC requirements.

The KSZ8051MNLU/RNLU design incorporates voltage-mode transmit drivers and on-chip terminations.

With the voltage-mode implementation, the transmit drivers supply the common-mode voltages to the two differential pairs. Therefore, the two transformer center tap pins on the KSZ8051MNLU/RNLU side should not be connected to any power supply source on the board; instead, the center tap pins should be separated from one another and connected through separate 0.1µF common-mode capacitors to ground. Separation is required because the common-mode voltage is different between transmitting and receiving differential pairs.

Figure 26 shows the typical magnetic interface circuit for the KSZ8051MNLU/RNLU.

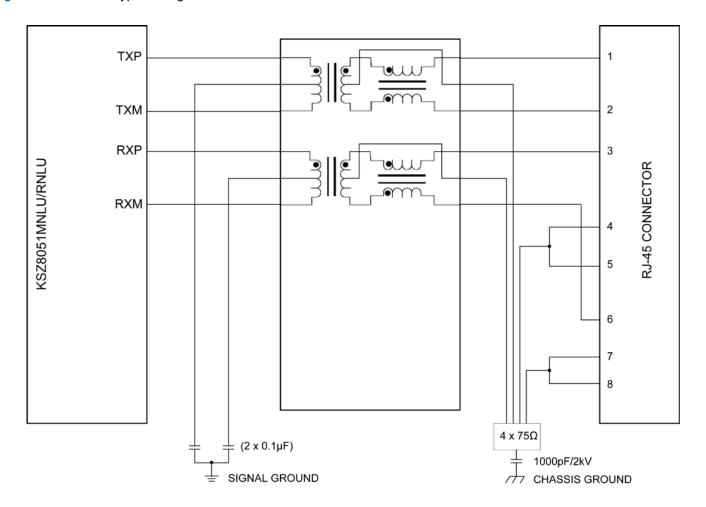


Figure 26. Typical Magnetic Interface Circuit

Table 25 lists recommended magnetic characteristics.

Parameter	Value	Test Condition
Turns ratio	1 CT : 1 CT	
Open-circuit inductance (min.)	350µH	100mV, 100kHz, 8mA
Insertion loss (typ.)	-1.1dB	100kHz to 100MHz
HIPOT (min.)	1500Vrms	

Table 25. Magnetics Selection Criteria

Table 26 is a list of compatible single-port magnetics with separated transformer center tap pins on the PHY chip side that can be used with the KSZ8051MNLU/RNLU.

Manufacturer	Part Number	Temperature Range	Magnetic + RJ-45
Bel Fuse	S558-5999-U7	0°C to 70°C	No
Bel Fuse	SI-46001-F	0°C to 70°C	Yes
Bel Fuse	SI-50170-F	0°C to 70°C	Yes
Delta	LF8505	0°C to 70°C	No
HALO	HFJ11-2450E	0°C to 70°C	Yes
HALO	TG110-E055N5	-40°C to 85°C	No
LANKom	LF-H41S-1	0°C to 70°C	No
Pulse	H1102	0°C to 70°C	No
Pulse	H1260	0°C to 70°C	No
Pulse	HX1188	-40°C to 85°C	No
Pulse	J00-0014	0°C to 70°C	Yes
Pulse	JX0011D21NL	-40°C to 85°C	Yes
TDK	TLA-6T718A	0°C to 70°C	Yes
Transpower	HB726	0°C to 70°C	No
Wurth/Midcom	000-7090-37R-LF1	-40°C to 85°C	No

Table 26. Compatible Single-Port 10/100 Magnetics

Recommended Land Pattern

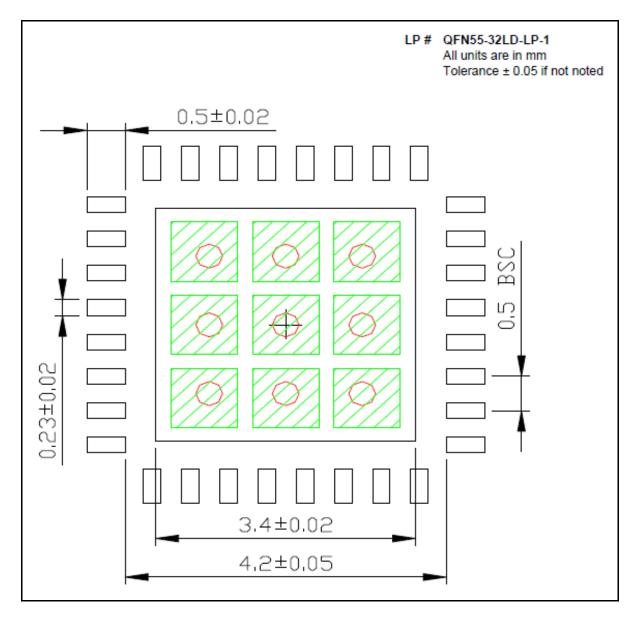
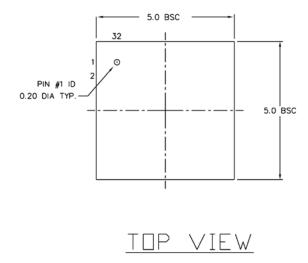


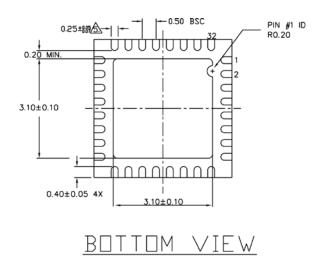
Figure 27. Recommended Land Pattern, 32-Pin (5mm x 5mm) QFN

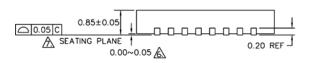
Red circles indicate thermal vias. They should be 0.350mm in diameter and be connected to the GND plane for maximum thermal performance.

Green rectangles (with shaded area) indicate solder stencil openings on the exposed pad area. They should be 0.87 x 0.87mm in size, 1.07mm pitch.

Package Information⁽¹⁾







- ALL DIMENSIONS ARE IN MILLIMETERS.

 MAX. PACKAGE WARPAGE IS 0.05 mm.

 MAXIMUM ALLOWABE BURRS IS 0.076 mm IN ALL DIRECTIONS.

 PIN #1 ID ON TOP WILL BE LASER/INK MARKED.

 DIMENSION APPLIES TO METALIZED TERMINAL AND IS MEASURED

 BETWEEN 0.20 AND 0.25 mm FROM TERMINAL TIP.
- APPLIED ONLY FOR TERMINALS.
- APPLIED FOR EXPOSED PAD AND TERMINALS.

SIDE VIEW

32-Pin (5mm x 5mm) QFN

Note:

Package information is correct as of the publication date. For updates and most current information, go to www.micrel.com.

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